

Nov 12 '03

Clock Generator
ICS950813 3Intel Mobile CPU
Banias/Dothan
4, 5, 6

S Note-1 Block Diagram

03209-2-Final

Keyboard Light

UNBUFFERED
On-Board DDR
SODIMM x 8
11, 12, 13, 15, 16UNBUFFERED
DDR SODIMM
Socket
14, 15, 16

DDR 200/266/333

AGTL+ FSB 400MHz

Intel
Motara-GM Plus
AGTL+ CPU I/F
DDR Memory I/F
INTEGRATED GRAHPICS
LVDS, CRT I/F
7, 8, 9, 10

LVDS

RGB CRT

12.1" XGA LCD
18CRT SELECTION
17Media Slice 46
CRT Port 19RICOH
R5C5811
Cardbus + SD Card
26, 27

MediaBay I/F

SD
Socket
30Power Switch
TPS2205 28PCMCIA
SLOT
29

Hub-LINK 66MHz

Media
Slice 46Secondary IDE
ATA 66/100HDD
23Primary IDE
ATA 66/100Intel
ICH4-M
USB 2.0 (2+2+2)
ETHERNET (10/100Mb)
AC97 2.2
ATA 66/100
ACPI 1.1
LPC I/F
PCI/PCI BRIDGE
INT. RTC
20, 21, 22

PCI Bus / 33MHz

Intel Ethernet
Giga LAN
82541EX 31, 32Mini-PCI
802.11a/b/g
34Intel Ethernet
10/100 PHY
82562EZ 31, 32

LAN MII

RJ45
CONN 33PMH-4
G/A 43

LPC Bus / 33MHz

KBC
H8S/2161B
41NS FIR & LPC SW
PC87382 45FWH
SST-49LF008 40LPC Debug
Board Conn 41TCPA
Chip 44USB 1 24, 25
USB 2 24, 25

CH2,3

Secondary IDE
USB Hub
SMSC
USB20H04Int. KB
Track point IV 42FIR
IRMS6452 39NX SIO
PC87392

Line In Line Out

UltraBay
HDD, Optical Drives
2nd Battery

Stereo Speaker x 2

USB x 3

Media Slice

PS/2 x2

MAX3243
RS232 Transceiver

COM Port

Parallel Port

CRT

RJ11

RJ45

DC-IN

46

PCB Layer Stackup

L1:Component

L2:GND

L3:Signal 1

L4:VCC

L5:Signal 2

L6:Signal 3

L7:GND

L8:Component

System DC/DC

MAX1977 53

INPUTS	OUTPUTS
VINT16	VCC5M
	VCC3M

Battery Charger/Selector

MAX1870 50

CV16	M-BAT-PWR
	S-BAT-PWR

GMCH CORE

MAX1992 55

VINT16	VCCGMCHCORE
	VCCCPU10

CPU DC/DC

MAX1907 54

VINT16	VCCCPUCORE
	VCCCPU10

VCCACPU/DDR_VREF

LP2996MR/MAX8873 57

VCC2R5A	DDR_VREF
VCC3M	VCCACPU

1.5/2.5 DC/DC

MAX1845 56

VINT16	VCC1R5M
	VCC2R5A

緯創資通

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
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Title		
Block Diagram		
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RESISTOR

Symbol name	Value	Tolerance (J: 5%, F: 1%, D: 0.5%, B: 0.1 %)	Rating 0402=> 1/16W, 25V 0603 => 1/16W, 75V 0805 => 1/10W, 100V	Size 2=>0402, 3=>0603, 5=>0805, 6=>1206, 0=>1210
10KR3	10K Ohm	If no letter, it means J: 5%	1/16W, 75V	0603
33D3R5	33.3 Ohm	If no letter, it means J: 5%	1/10W, 100V	0805
1KR3F	1K Ohm	F: 1%	1/16W, 75V	0603

The naming rule is value + R + size + tolerance
For the value, it can be read by the number before R. (R means resistor)
For the tolerance, it can be read from the last letter.
For the rating, we don't show on the symbol name.
For the size, R2=>0402, R3=>0603, R5=>0805,....

CAPACITOR

Symbol name	Value	Tolerance (M: +/-20, K: +/-10, Z: +80/-20)	Rating	Size 2=>0402, 3=>0603, 5=>0805, 6=>1206, 0=>1210
SCD1U10V2MX-1	0.1uF	M/X5R	10V	0402
SC10U6D3V5MX	10uF	M/X5R	6.3V	0805
SC2D2U16V5ZY	2.2uF	Z/Y5V	16V	0805

The naming rule is
Capacitor type + value + rating + size + tolerance + material
SCD1U10V2MX-1
SC=> SMT Ceramic, TC=> POS cap or SP cap
D1U => 0.1uF
10V => the voltage rating is 10V
2=> 0402, 3=>0603, 5=>0805
M=>tolerance M, K, Z
X=> X7R/X5R, Y=> Y5V
-1 => symbol version, nonsense to EE characteristic

PCI TABLE

DEVICE	IDSEL	IRQ	REQ# / GNT#
MINIPCI SLOT	AD18	F, G	REQ# 2/ GNT#2
CARDBUS R5C593	AD16	SERIRQ	REQ#0 / GNT#0
AGP			
LAN(82562EX)	AD24(Int.)	E	
LAN(82541EI)	AD17	E	REQ#1 / GNT#1
USB UHCI	AD29	A, D, C	
USB 2.0 EHCI	AD29	H	
Hub-to-PCI	AD30		
LPC Bridge/ IDE/AC97/ SMBus	AD31		

PLANAR_ID[2..0]

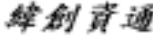
ICH4-M GPIO _n	34	33	32	Snote-1 Planar ID Version	Planar PCB Version
PLANAR_ID _n	2	1	0		
	0	0	0	SDV-1, SVT-R	03209-SA, 03209-2
	0	0	1	SDV-2	03209-SA
	0	1	0	SDV-3	03209-SA
	0	1	1	SIV	03209-SB
	1	0	0	SIV-R	03209-SC
	1	0	1	SIT	03209-SD
	1	1	0	SIT-R	03209-SE
	1	1	1	SVT	03209-1

MEM_BASE_ID[4..0]

ICH4-M GPIO _n	39	38	37	36	35	Total Capacity	Density	Q'ty	Chip P/N
BASE_MEM_ID _n	4	3	2	1	0				
	0	1	0	0	0	256MB	256Mb	8	Infineon p/n HYB25D256160CT-6 (Rev D11 / 0.11um)
	0	1	0	0	1	256MB	256Mb	8	Micron p/n MT46V16M16TG-6T C (Rev T16 / 0.13um)
	0	1	0	1	0	256MB	256Mb	8	Samsung p/n K4H561638D-TCB3 (Rev D / 0.13um)
	1	0	0	1	1	256MB	512Mb	4	Hynix p/n HY5DU121622AT-J (Rev PC / 0.13um)
	1	0	0	0	1	256MB	512Mb	4	Micron p/n MT46V32M16TG-6T C (Tev T27 / 0.11um)
	1	0	0	1	0	256MB	512Mb	4	Samsung p/n K4H511638B-TCB3 (Rev B / 0.10um)
	1	1	0	1	1	512MB	512Mb	8	Hynix p/n HY5DU121622AT-J (Rev PC / 0.13um)
	1	1	0	0	1	512MB	512Mb	8	Micron p/n MT46V32M16TG-6T C (Tev T27 / 0.11um)
	1	1	0	1	0	512MB	512Mb	8	Samsung p/n K4H511638B-TCB3 (Rev B / 0.10um)

MEM_BASE_ID[4..0]

ICH4 GPIO bit 39 : Memory technology bit
1 : 512Mbit technology
0 : 256Mbit technology
ICH4 GPIO bit 38 : population numbers(bank numbers)
1 : total 8pcs
0 : total 4pcs
ICH4 GPIO bit 37-35 : vendor name
0 - 1 - 1 : Hynix
0 - 1 - 0 : Samsung
0 - 0 - 1 : Micron
0 - 0 - 0 : Infineon



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Title

Reference

Size
A3

Document Number

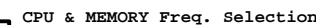
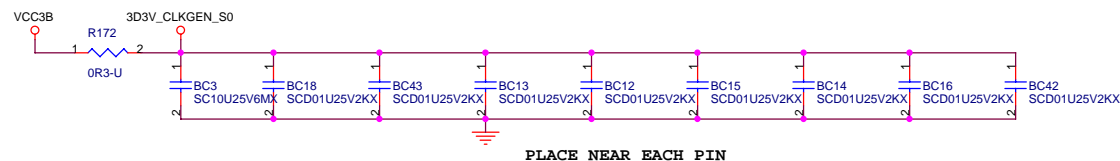
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Rev
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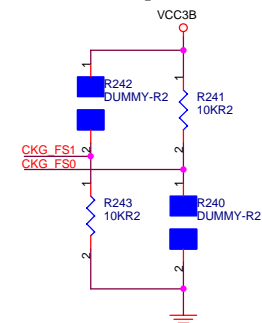
Date: Wednesday, June 01, 2005

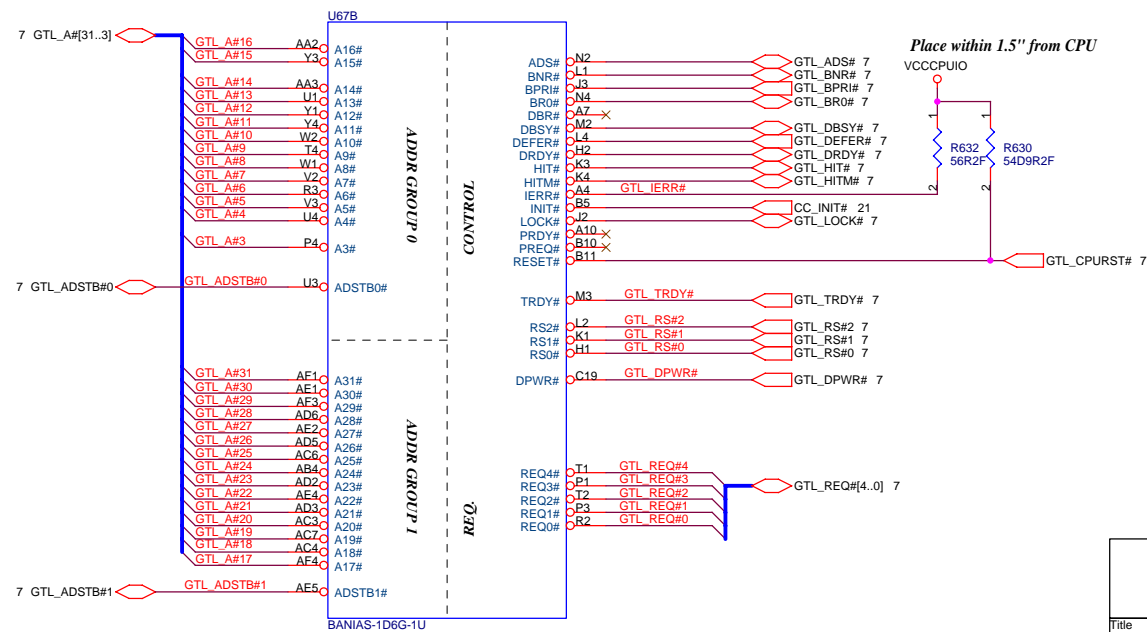
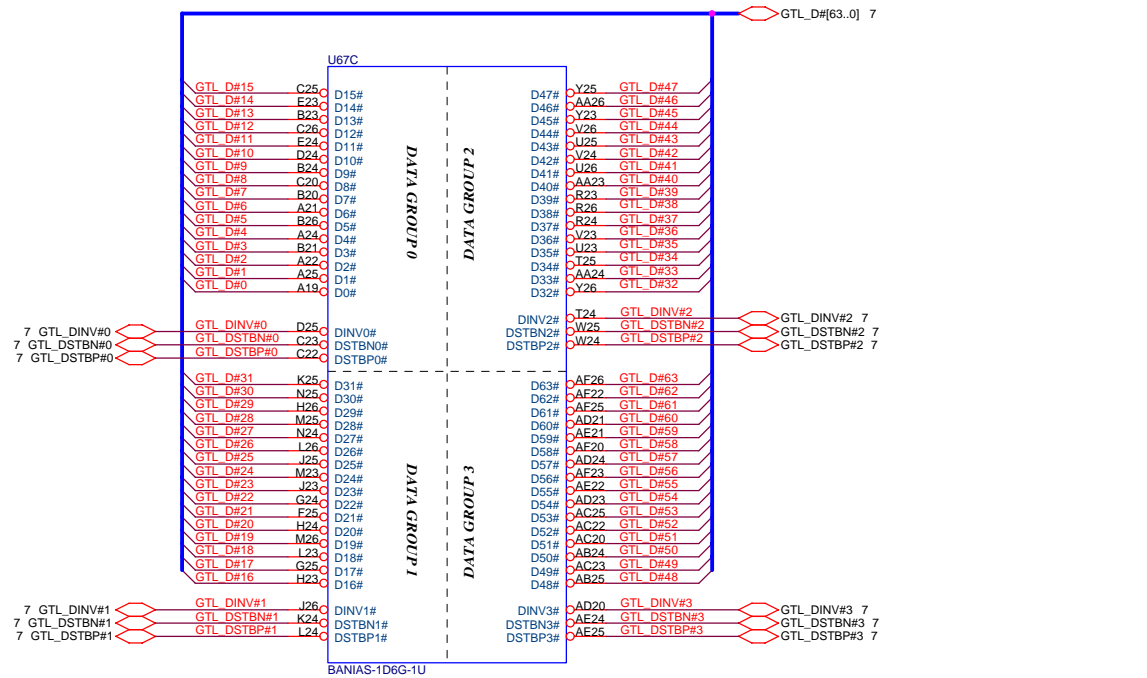
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E



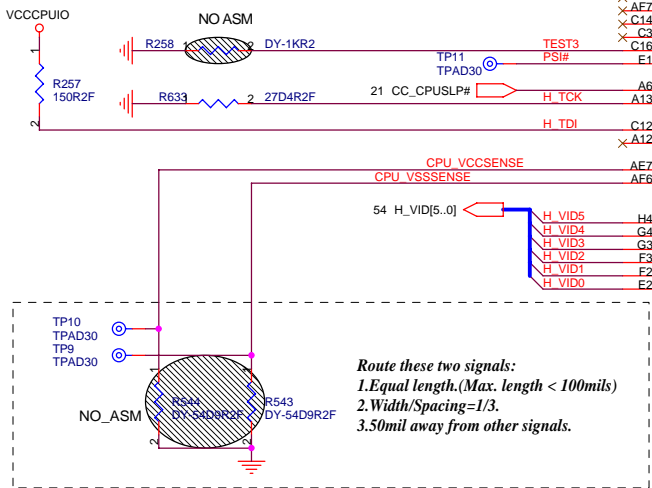
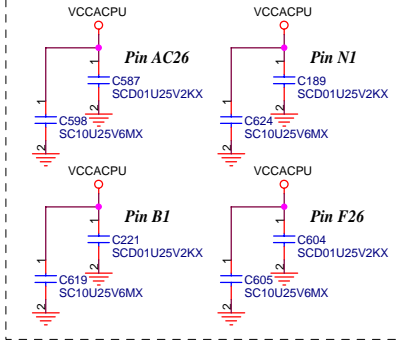
Frequency Setting	CPU	AGP	PCI
FS1/0 = 00	166.66MHz(ICS) 66.66MHz(CYPRESS)	66.67MHz	33.33MHz
FS1/0 = 01	100.00MHz	66.67MHz	33.33MHz
FS1/0 = 10	200.00MHz	66.67MHz	33.33MHz
FS1/0 = 11	133.33MHz	66.67MHz	33.33MHz
Mult0 = 0	Rr=221, Iref=5mA =>Vswing=1.0V @50ohm		
Mult0 = 1	Rr=475, Iref=2.32mA =>Vswing=0.7V @50ohm		



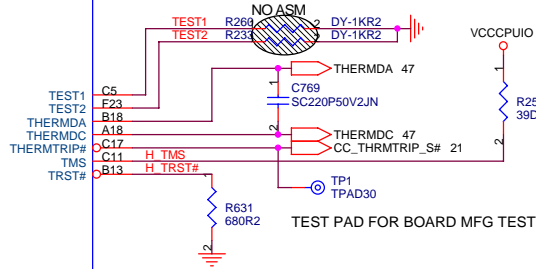
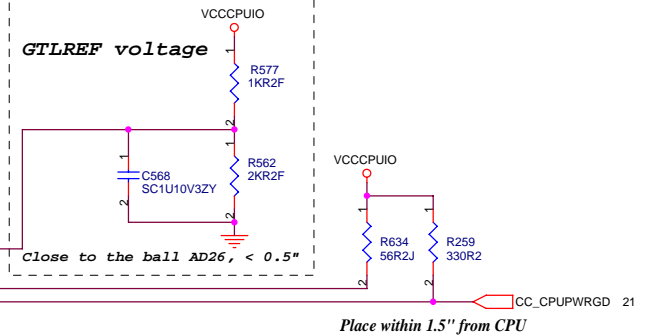
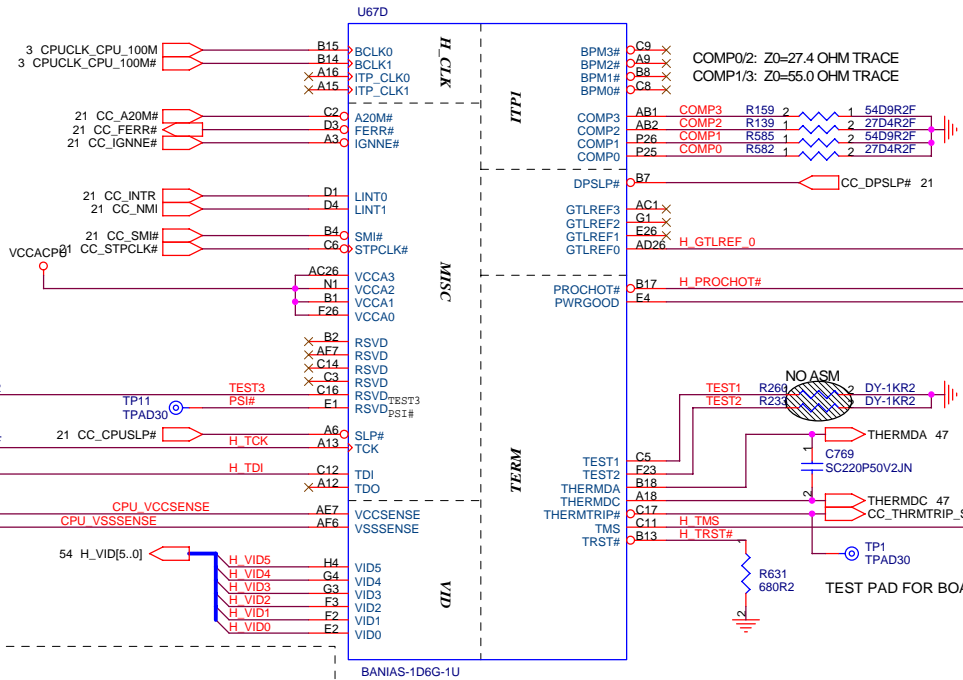
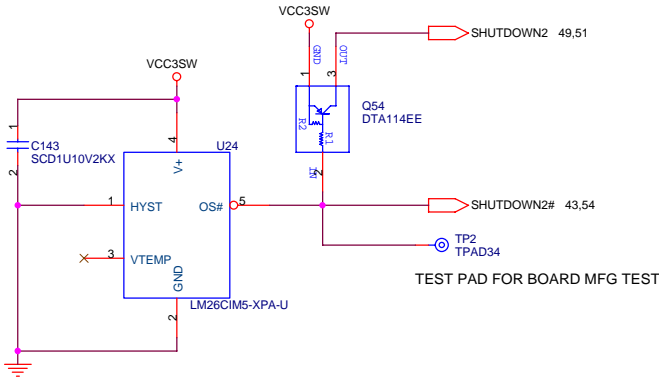


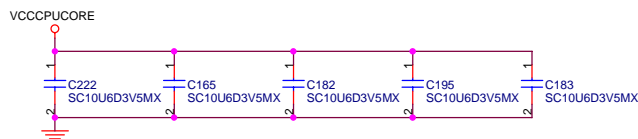
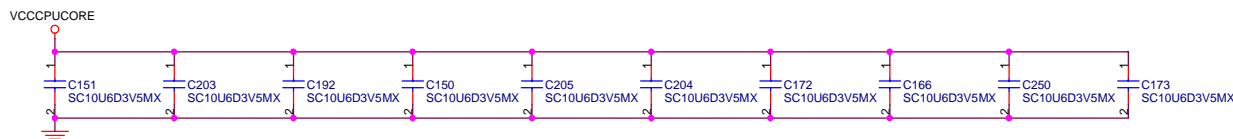
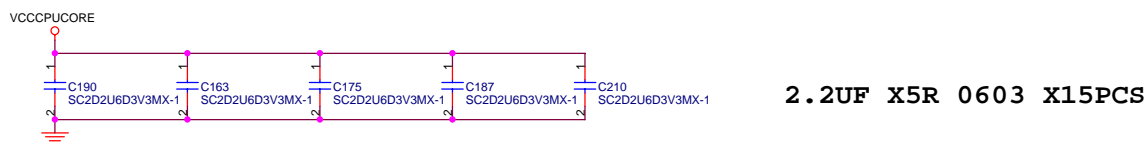
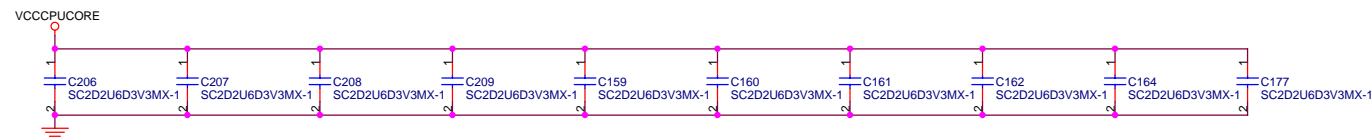
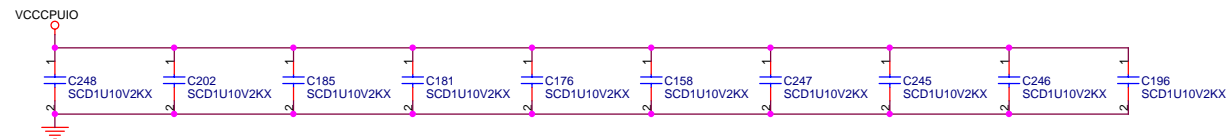
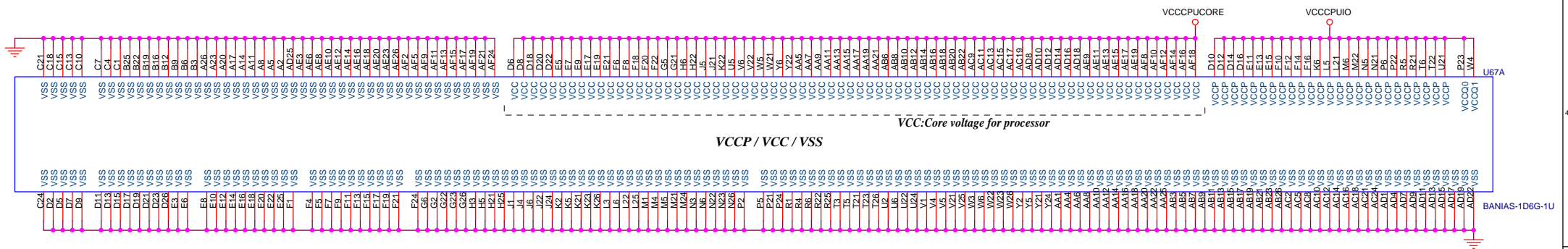
	VCCACPU
BANIAS	1.80V
DOTHAN	1.50V

For CPU VCCA[0:3] PLL
place one 0.01u & 10u
for each VCCA pin




Route these two signals:
1. Equal length.(Max. length < 100mils)
2. Width/Spacing=1/3.
3. 3.50mil away from other signals.





2.2UF X5R 0603 X15PCS

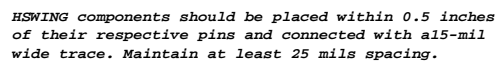
10UF X5R 0805 X15PCS

 <div style="display: inline-block; vertical-align: middle; text-align: center;"> Wistron Corporation 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C. </div>	
Title	
BANIAS CPU(3/3) <i>S Note-1</i>	
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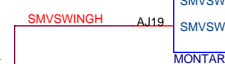
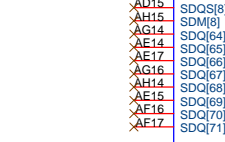
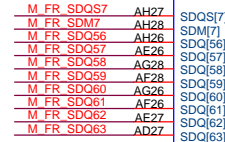
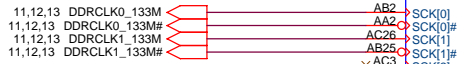
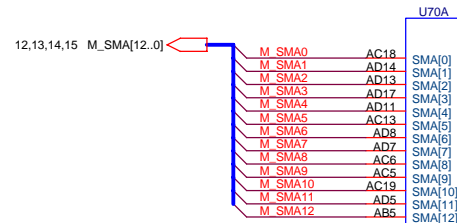
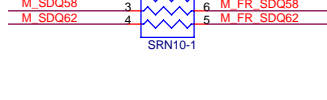
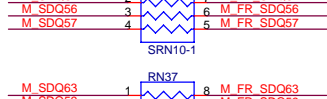
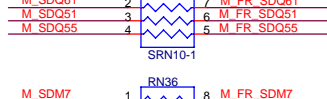
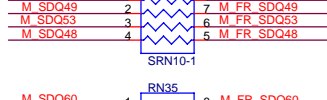
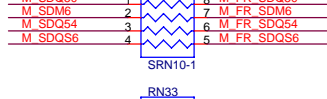
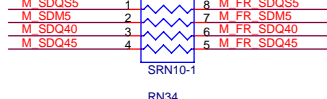
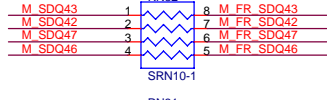
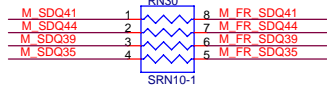
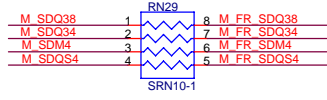
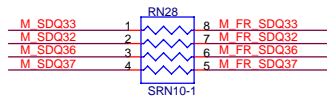
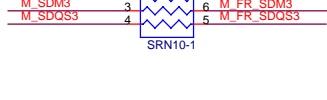
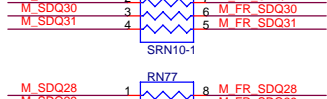
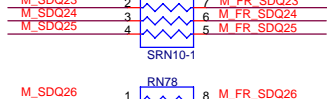
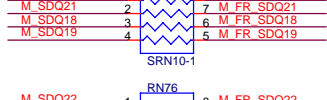
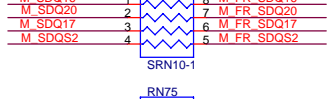
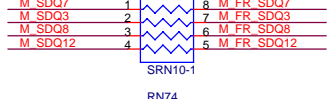
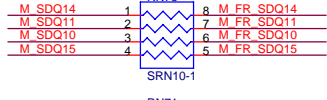
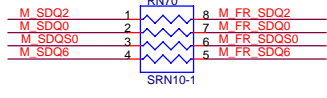
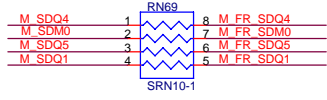
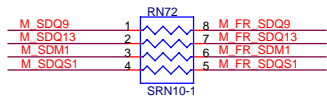
2. These signals are inverted on the CPU bus

2. The address inverted on the CPU bus

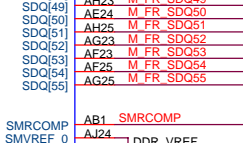
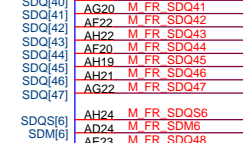
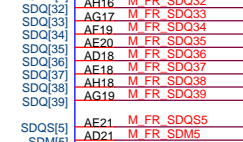
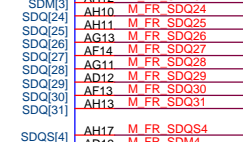
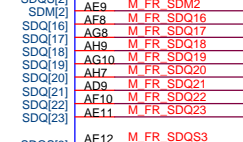
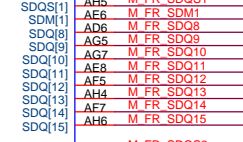
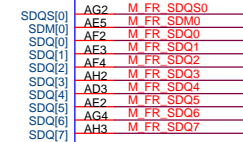
Defines the attributes of the request

[illegible]

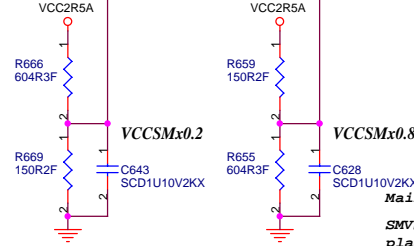
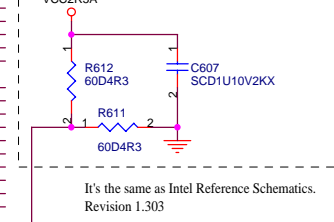
11,14,15 M_SDO[63..0]
11,14,15 M_SDO[7..0]
11,14,15 M_SDM[7..0]



DDR MEMORY



This signal may be optionally connected to Vcc2_5 and powered off in S3. The SMRCOMP signal should be a minimum of 12 mils wide and be isolated from other signals with a minimum of 10 mils spacing.



SMVSWINGL and SMVSWINGH components should be placed within 0.5 inches of their respective pins and connected with a 15-mil wide trace.

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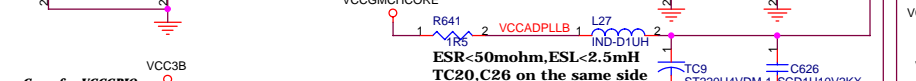
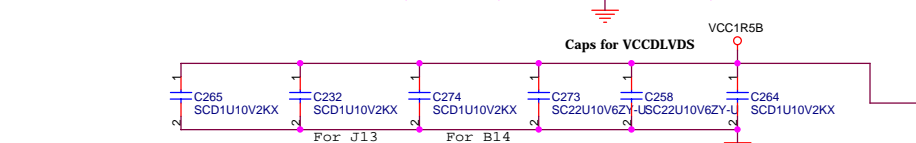
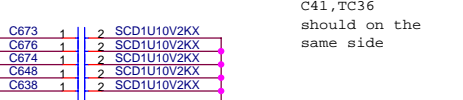
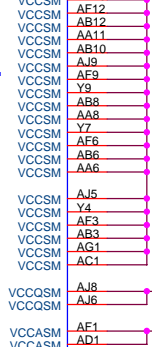
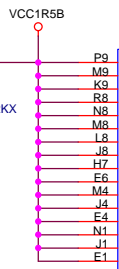
MONTARA GM+(2/4)

S Note-1

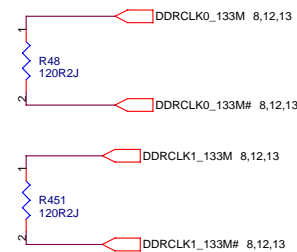
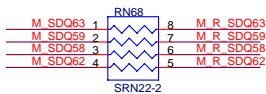
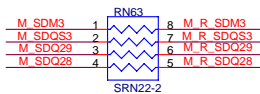
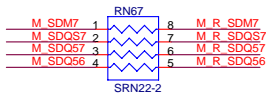
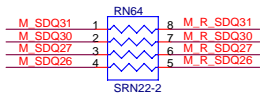
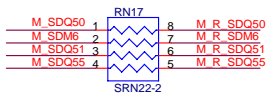
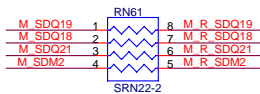
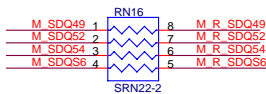
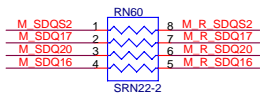
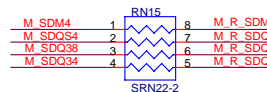
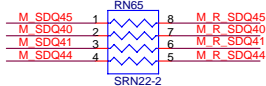
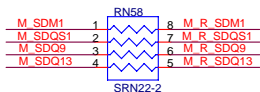
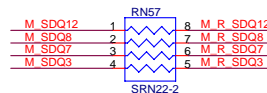
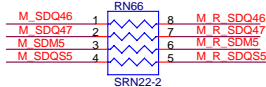
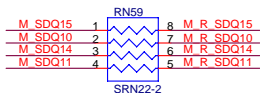
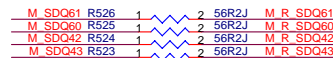
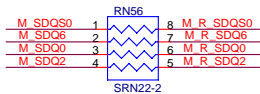
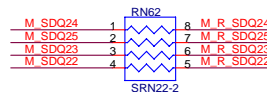
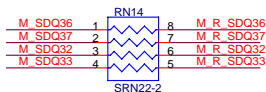
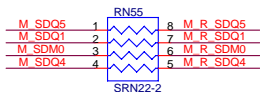
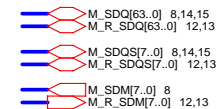
Rev -2

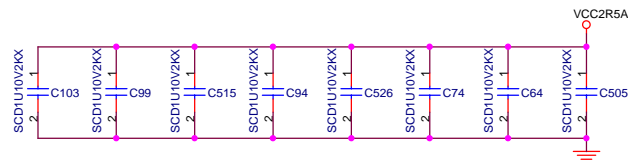
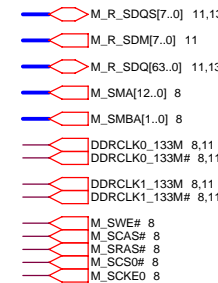
Date: Wednesday, June 01, 2005

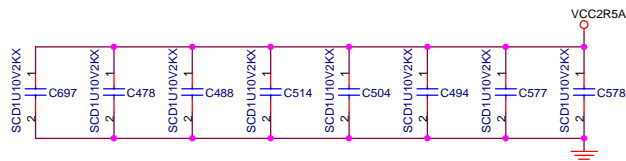
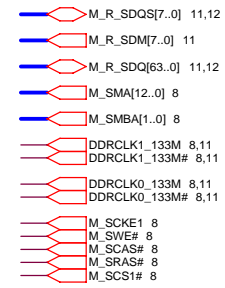
Sheet 8 of 66

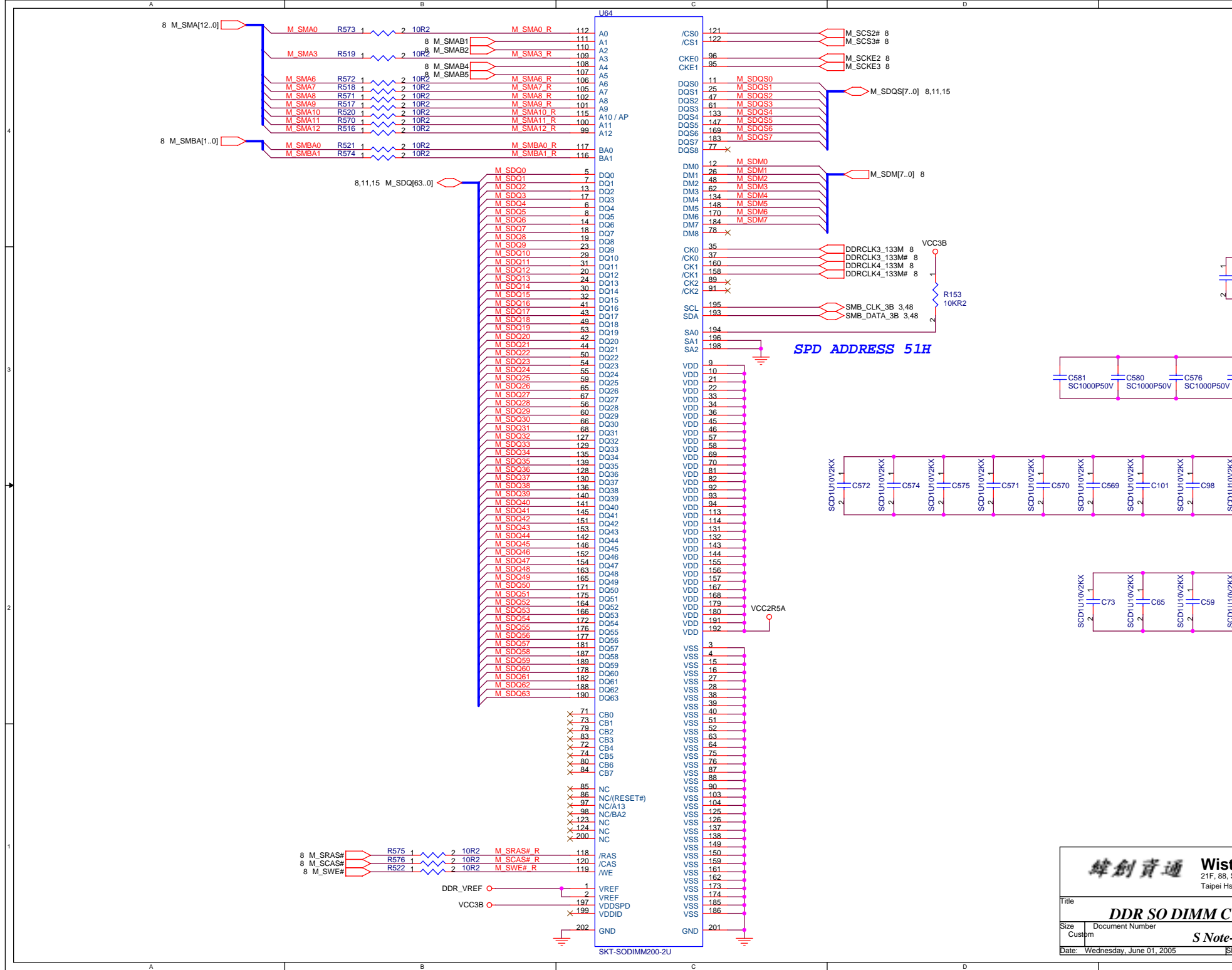


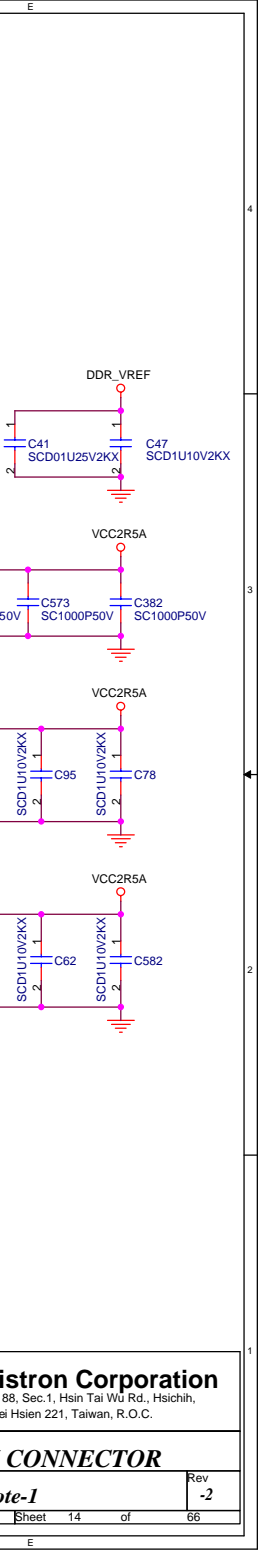
A

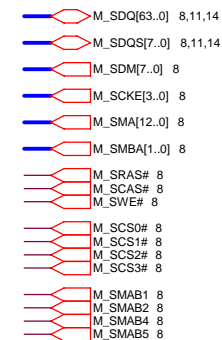
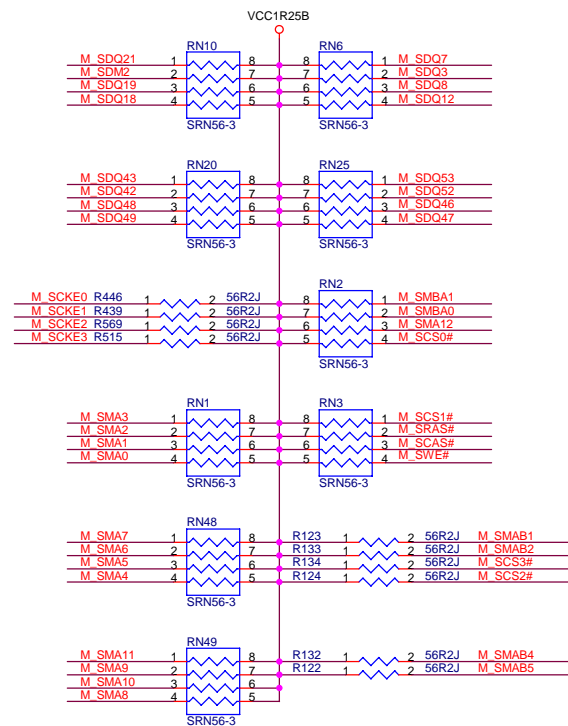


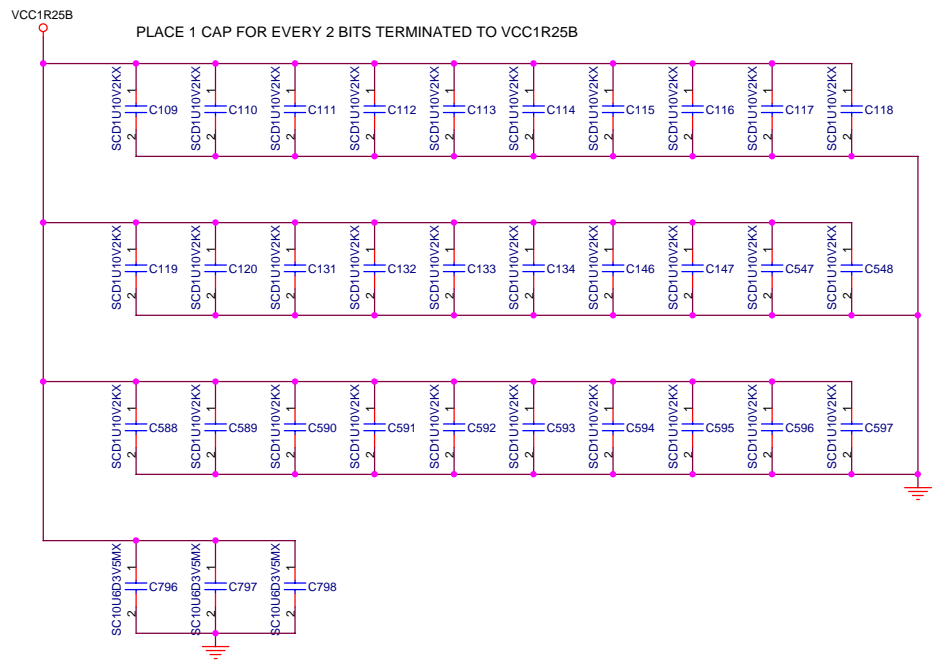


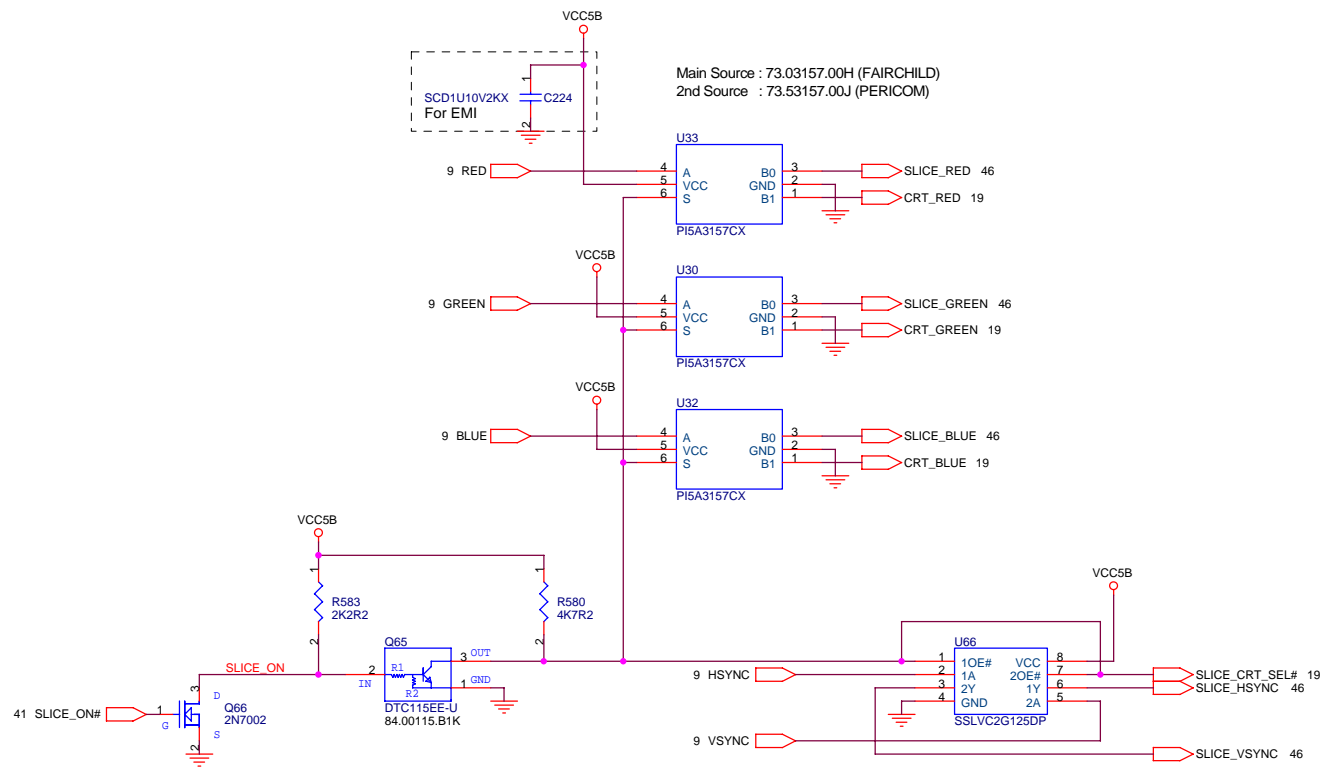










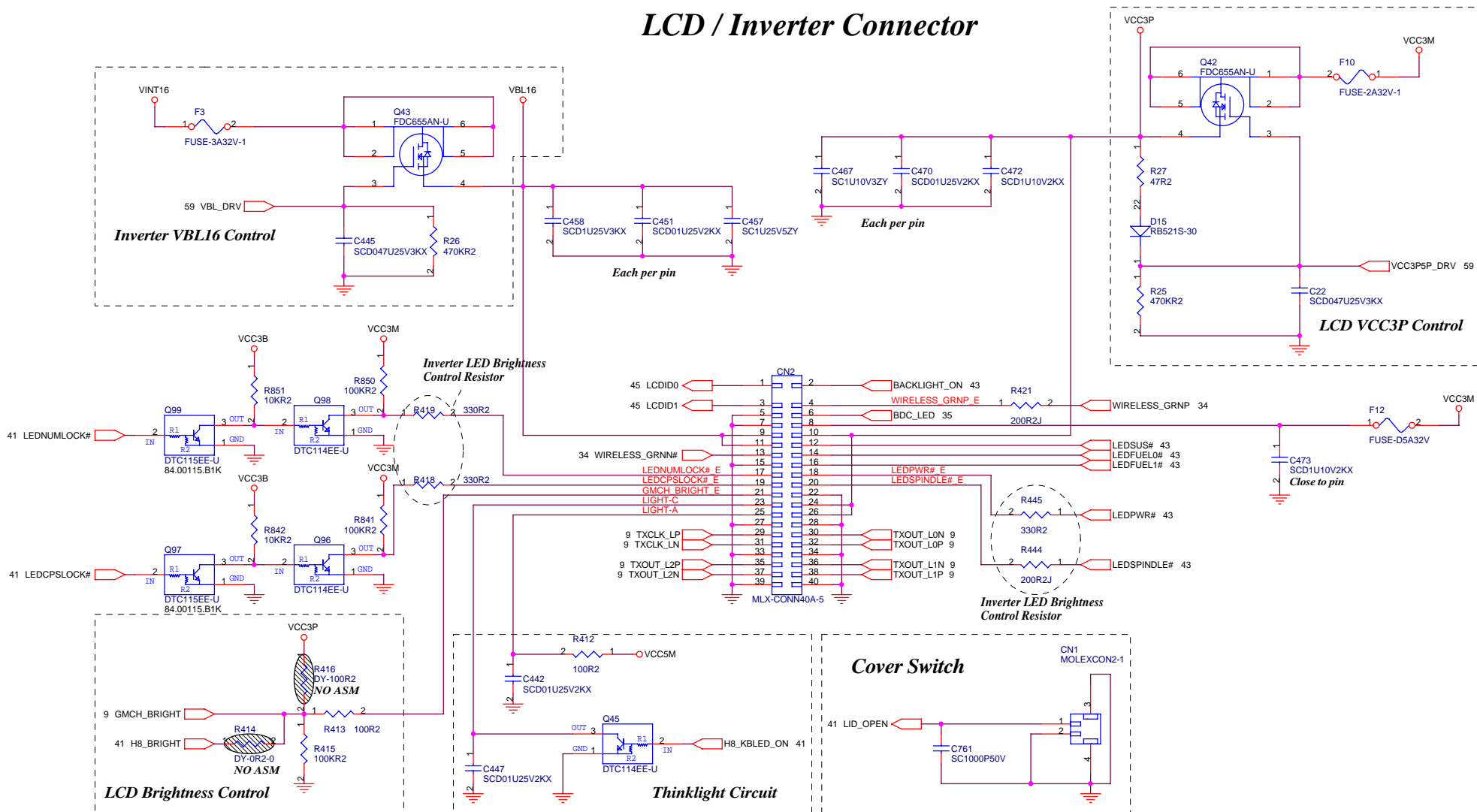


緯創資通

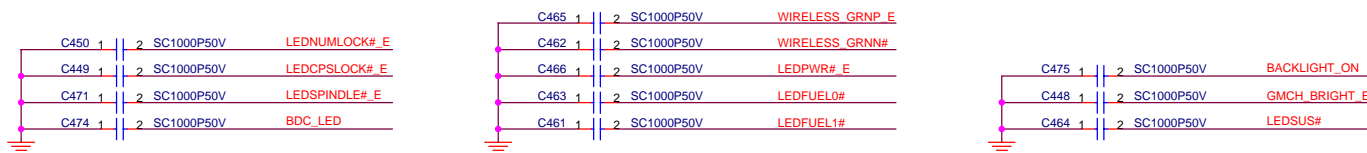
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Taipei Hsien 221, Taiwan, R.O.C.

Title			
CRT SELECTION			
Size A3	Document Number	Rev -2	
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LCD / Inverter Connector



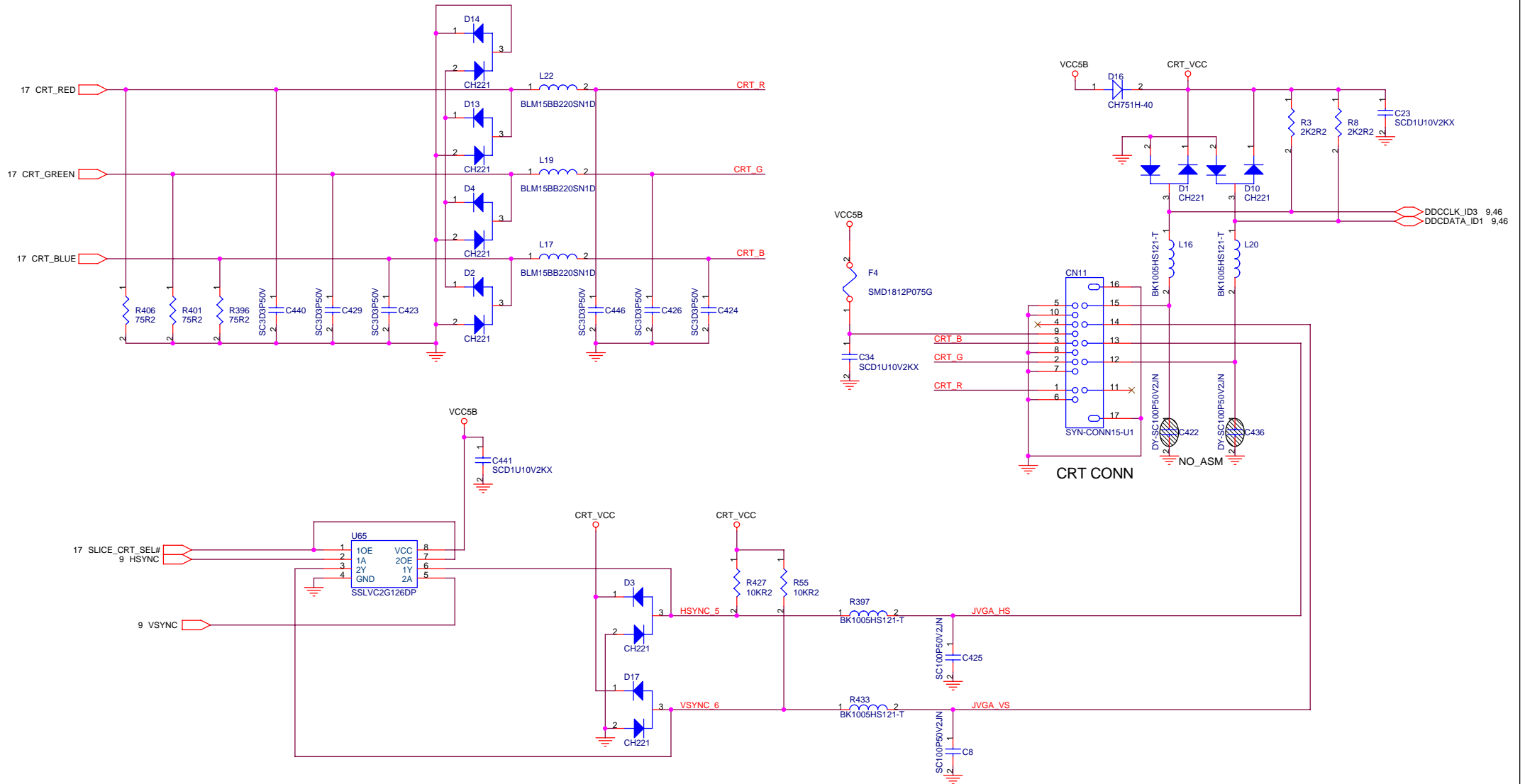
Capacitors For EMI



Pi-filter for RGB

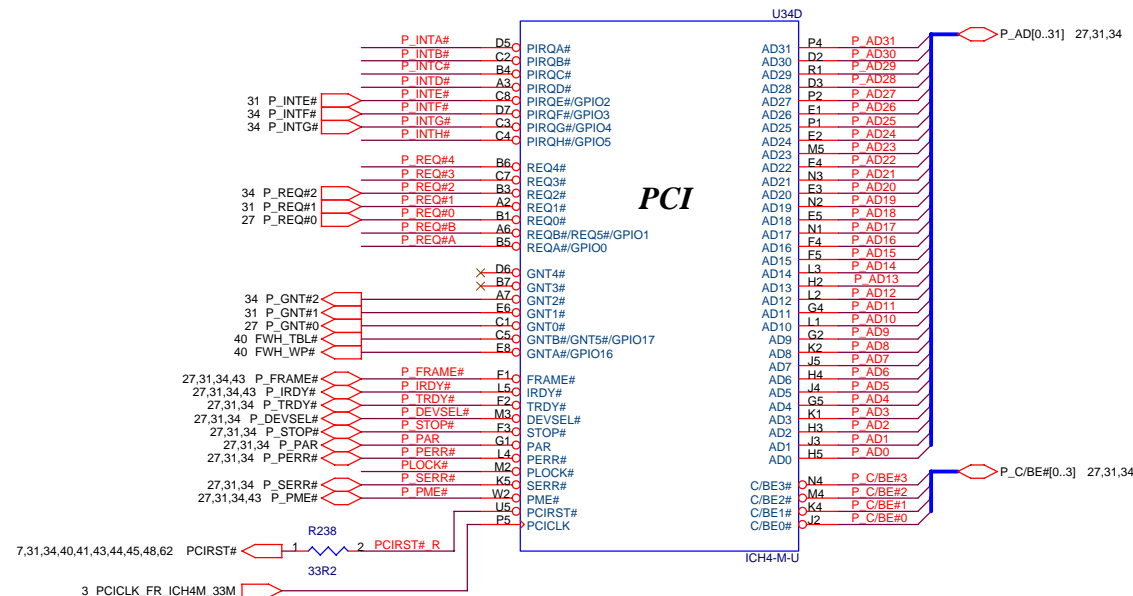
Pi-filter & 75 Ohm pull-down resistors should be as close as to CRT CONN. RGB will hit 75 Ohm first, pi-filter, then CRT CONN.

Ferrite bead impedance: 22ohm@100MHz



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Title		
EXT CRT CONNECTOR		
Size	Document Number	Rev
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REV.NO. 2.0
REF.NO. 12232
P.66

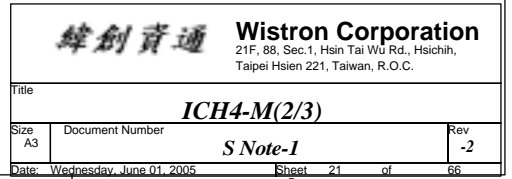
RTC Circuit

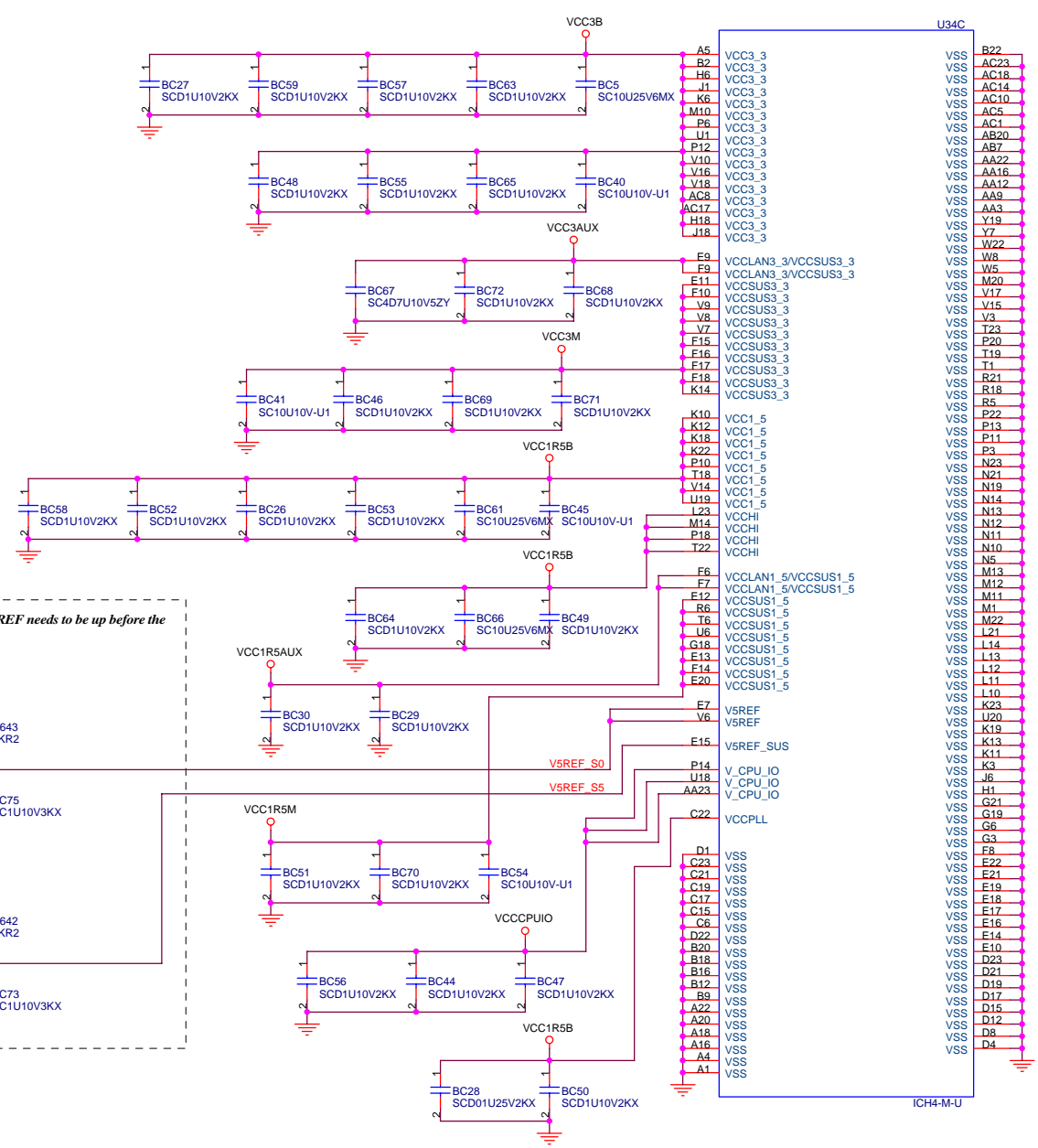
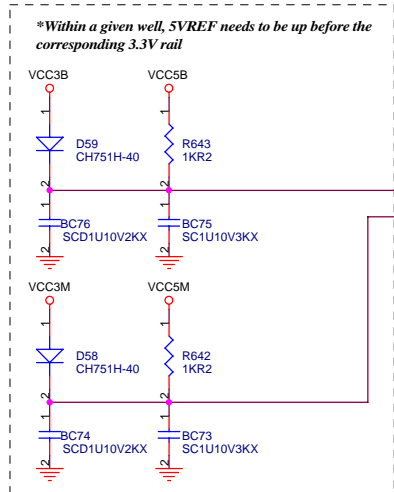
The schematic shows the internal connections for the Real Time Clock (RTC) module. Key components include:

- VCC3M**: Main power supply input.
- RTCVCC**: Power supply for the RTC module.
- VCC3SW**: Switched main power supply.
- D25 CH751H-40**: Schottky diode for VCC3SW.
- Q20 DY-2SA1774-U**: NPN transistor used as a switch or buffer.
- R780**, **R164**, **R165**, **R168**, **R191**, **R192**: Resistors for current limiting and timing.
- BC9 SC1U10V3KX**, **BC10 SC1U10V3KX**, **BC2 SCD047U25V3KX**, **BC6 SC12P50V2JN-1**: Various capacitors for decoupling and timing.
- D24 CH751H-40**: Schottky diode for RTCRST# signal.
- COPPER OPEN U**: A specific component or test point related to the copper layer.
- GP1**: General Purpose Input/Output pin.
- RTCRST# delay 18~25ms**: Timing requirement for the reset signal.
- X3 X-32D768KHZ-15**: 32.768 kHz crystal oscillator.
- KDS RESO 32.768KHZ 12P**: Resonator specification.
- MLX-CON3-3**: Multi-pin connector for CN5.

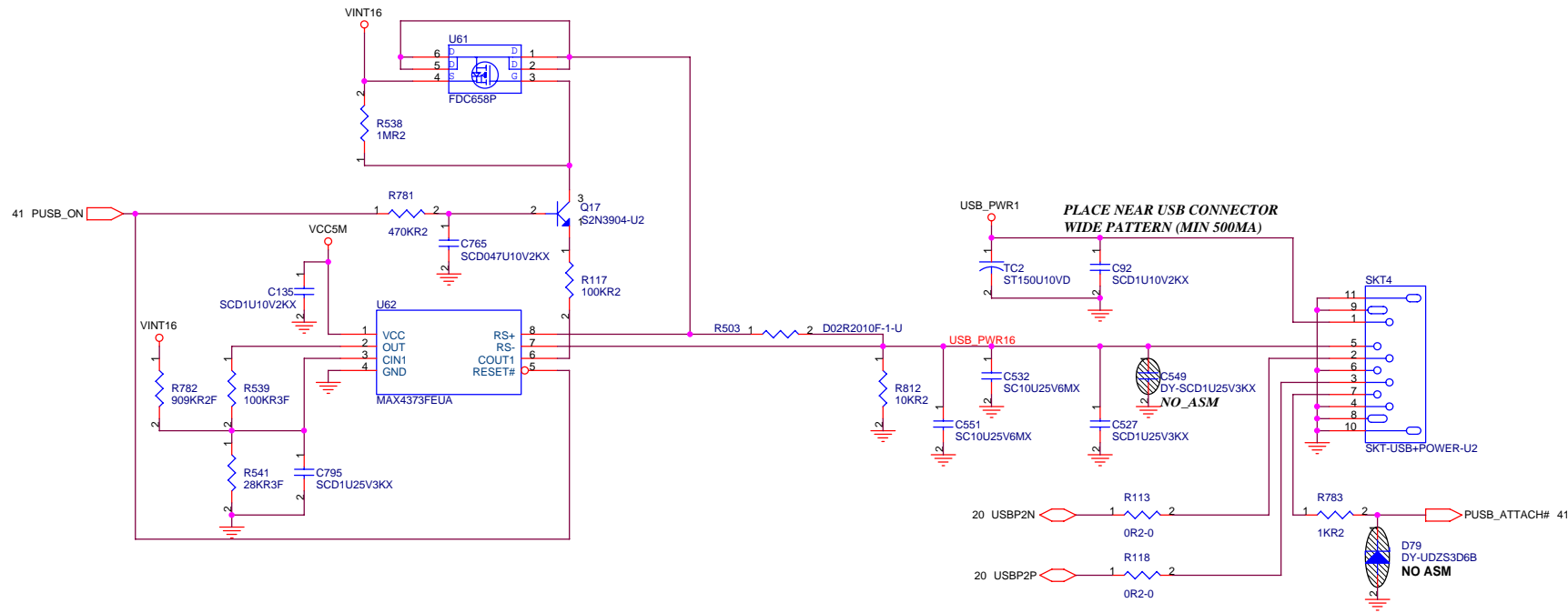
The circuit includes several labels indicating layout requirements: "LAYOUT: MAKE PAD ACCESSABLE" and "NO_ASM". It also shows various pins like **RTCX1**, **RTCX2**, **ICH_VBIAS**, and **RTC_BAT_IN#**.

The schematic diagram illustrates the IDE1 & IDE2 interface. It shows the connection between the IDE1 chip (U34E) and the IDE2 chip (U34F). The IDE1 chip has pins for PIDE_D[15..0], PIDE_A[15..0], PIDE_IOW#, PIDE_DACK#, PIDE_DREQ, PIDE_IOR#, PIDE_A0, PIDE_A1, PIDE_A2, PIDE_CS1#, PIDE_CS3#, and IRQ14/IRQ15. The IDE2 chip has pins for SIDE_D[15..0], SIDE_A[15..0], SDIOW#, SDDACK#, SDDREQ, SDIOR#, SIORDY, SIDE_A0, SIDE_A1, SIDE_A2, SIDE_CS1#, SIDE_CS3#, and IRQ14/IRQ15. The diagram also shows power supply connections for VCC3B, including resistors R181, R47R2, R581, R47R2, R852, and 1MR2.

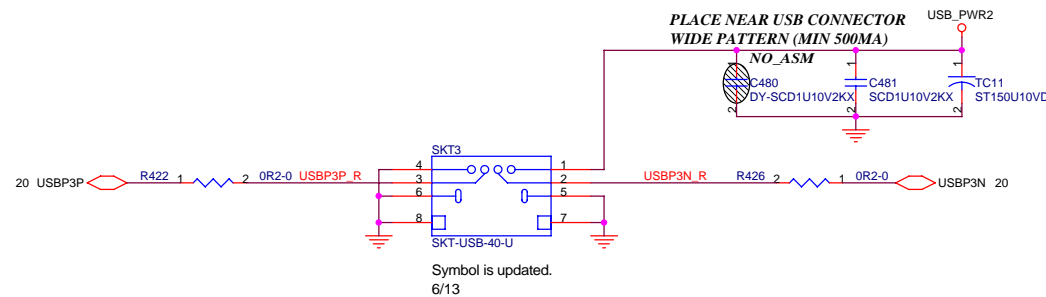


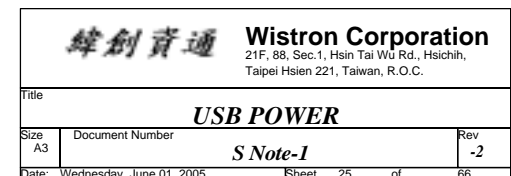


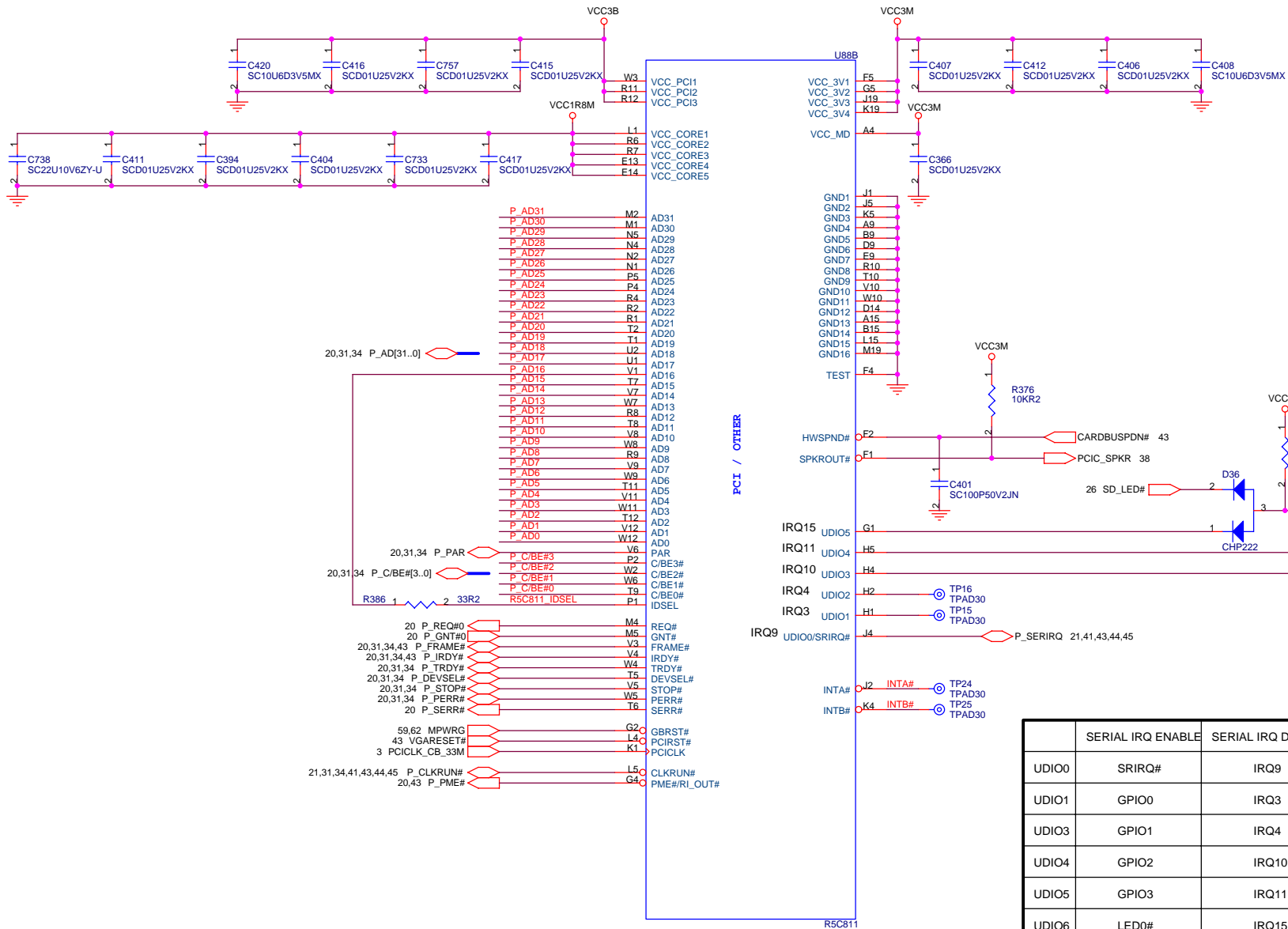
Powered USB Connector



USB Connector







PCI / OTHER

INTA#

INTB#

INTC#

INTD#

INTE#

INTF#

INTG#

INTH#

INTI#

INTJ#

INTK#

INTL#

INTM#

INTN#

INTO#

INTP#

INTQ#

INTR#

INTS#

INTT#

INTU#

INTV#

INTW#

INTX#

INTY#

INTZ#

INTAA#

INTAB#

INTAC#

INTAD#

INTAE#

INTAF#

INTAG#

INTAH#

INTAI#

INTAJ#

INTAK#

INTAL#

INTAM#

INTAN#

INTAO#

INTAP#

INTAQ#

INTAR#

INTAS#

INTAT#

INTAU#

INTAV#

INTAW#

INTAX#

INTAY#

INTAZ#

INTBA#

INTBB#

INTBC#

INTBD#

INTBE#

INTBF#

INTBG#

INTBH#

INTBI#

INTBJ#

INTBK#

INTBL#

INTBM#

INTBN#

INTBO#

INTBP#

INTBQ#

INTBR#

INTBS#

INTBT#

INTBU#

INTBV#

INTBW#

INTBX#

INTBY#

INTBZ#

INTCA#

INTCB#

INTCC#

INTCD#

INTCE#

INTCF#

INTCG#

INTCH#

INTCI#

INTCJ#

INTCK#

INTCL#

INTCM#

INTCN#

INTCO#

INTCP#

INTCQ#

INTCR#

INTCS#

INTCT#

INTCU#

INTCV#

INTCW#

INTCX#

INTCY#

INTCZ#

INTDA#

INTDB#

INTDC#

INTDD#

INTDE#

INTDF#

INTDG#

INTDH#

INTDI#

INTDJ#

INTDK#

INTDL#

INTDM#

INTDN#

INTDO#

INTDP#

INTDQ#

INTDR#

INTDS#

INTDT#

INTDU#

INTDV#

INTDW#

INTDX#

INTDY#

INTDZ#

INTEA#

INTEB#

INTEC#

INTED#

INTEF#

INTEG#

INTEH#

INTEI#

INTEJ#

INTEK#

INTEL#

INTEM#

INTEN#

INTEO#

INTEP#

INTEQ#

INTER#

INTES#

INTET#

INTEU#

INTEV#

INTEW#

INTEX#

INTEY#

INTEZ#

INTFA#

INTFB#

INTFC#

INTFD#

INTEF#

INTFG#

INTFH#

INTFI#

INTFJ#

INTFK#

INTFL#

INTFM#

INTFN#

INTFO#

INTFP#

INTFQ#

INTFR#

INTFS#

INTFT#

INTFU#

INTFV#

INTFW#

INTFX#

INTFY#

INTFZ#

INTGA#

INTGB#

INTGC#

INTGD#

INTEF#

INTGG#

INTGH#

INTGI#

INTGJ#

INTGK#

INTGL#

INTGM#

INTGN#

INTGO#

INTGP#

INTGQ#

INTGR#

INTGS#

INTGT#

INTGU#

INTGV#

INTGW#

INTGX#

INTGY#

INTGZ#

INTHA#

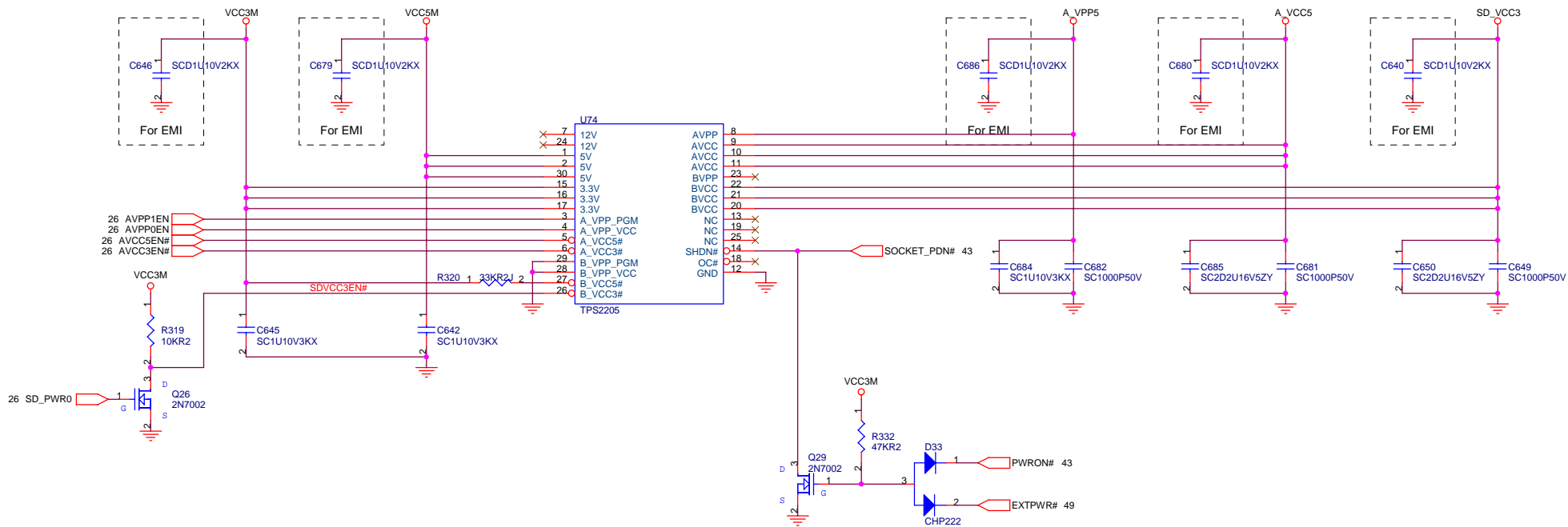
INTHB#

INTHC#

INTHD#

INTEF#

INTHH#



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Title

CARD BUS POWER CONTROL

Size

A3 Document Number

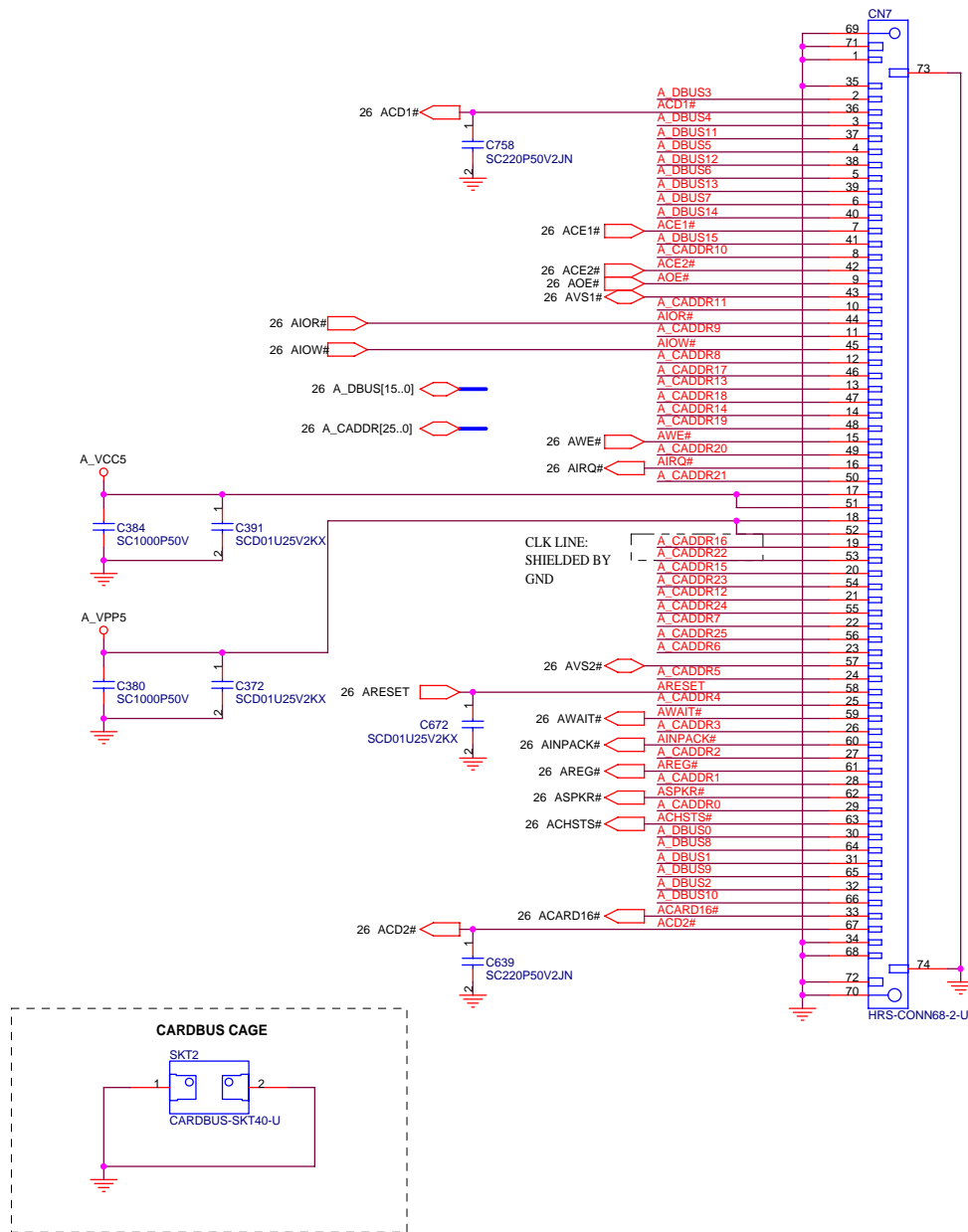
S Note-1

Rev

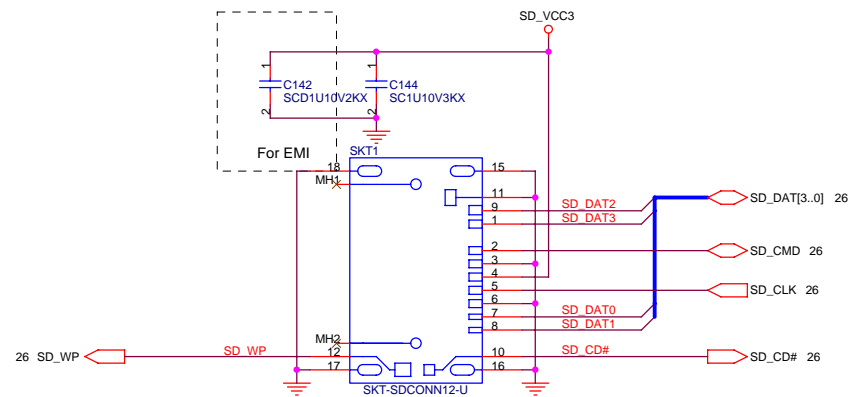
-2

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SD Slot



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Title

SD SLOT

Size
A3

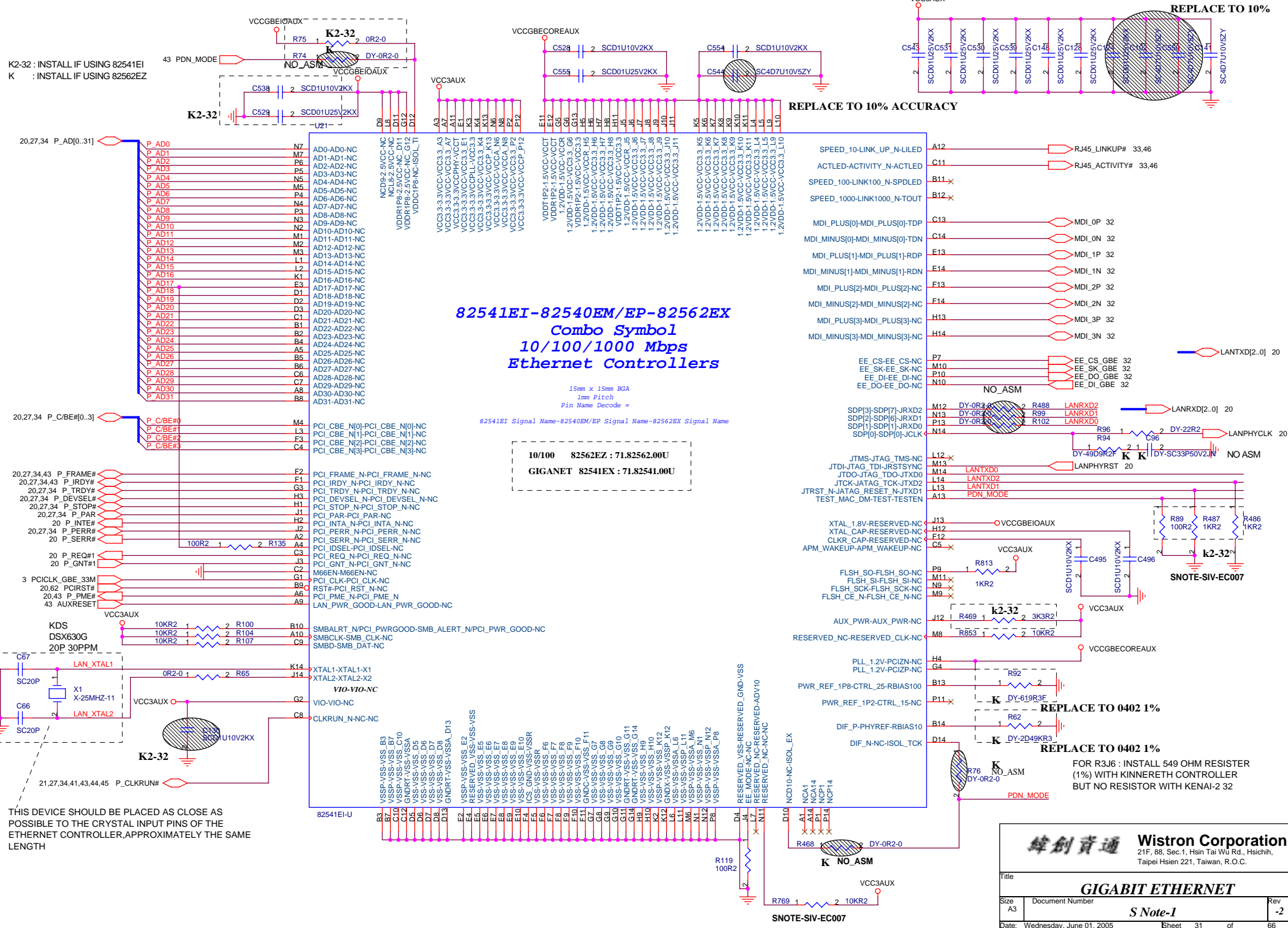
Document Number

S Note-1

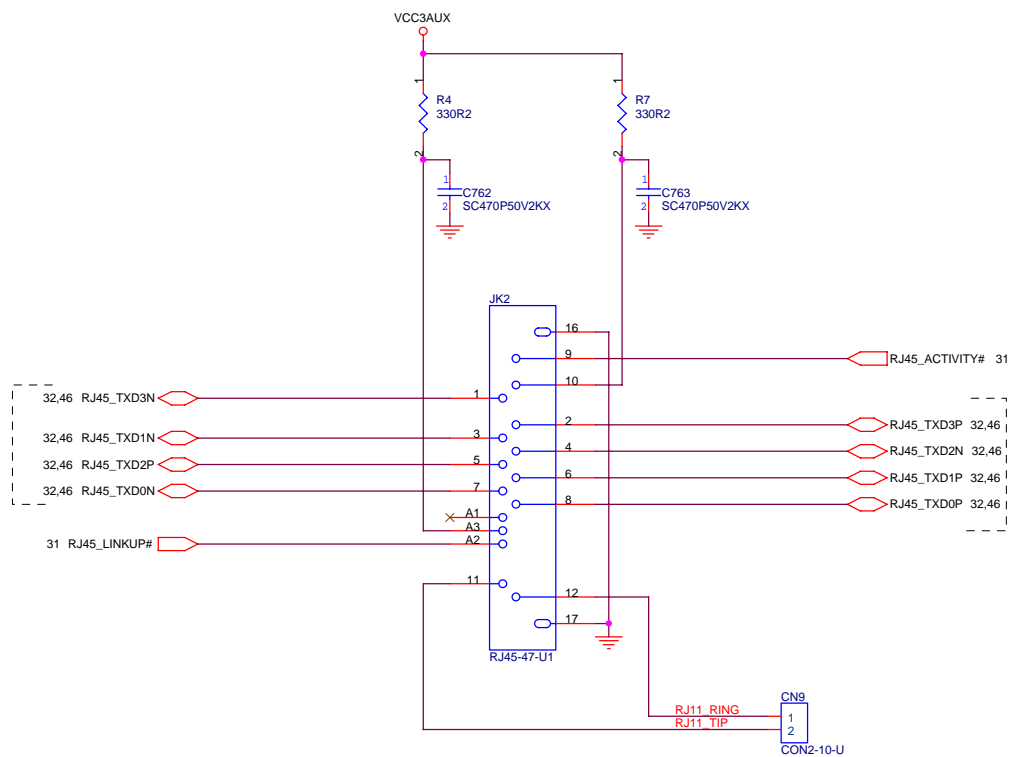
Rev
-2

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KEEP AWAY FROM OTHER
TRACES

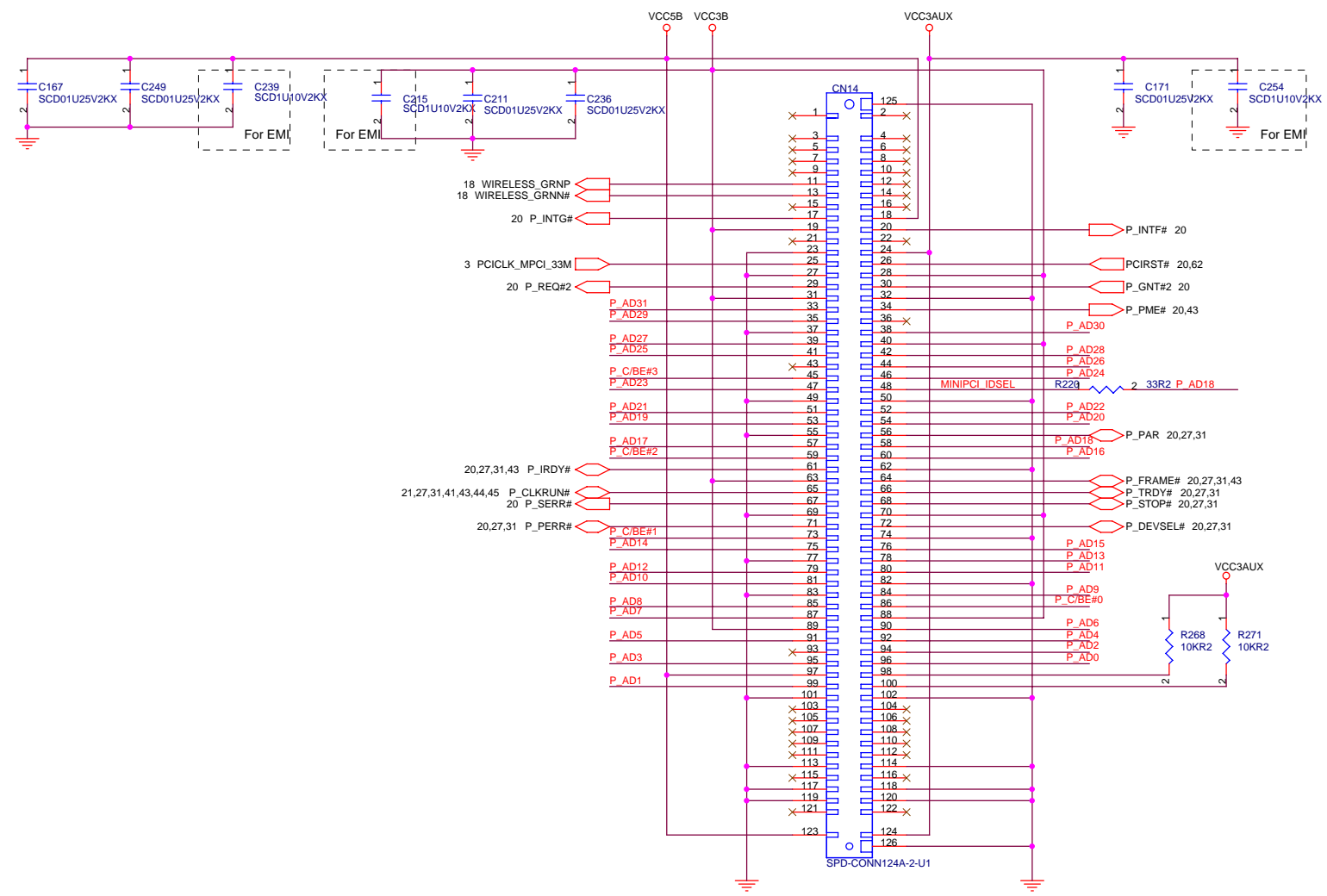


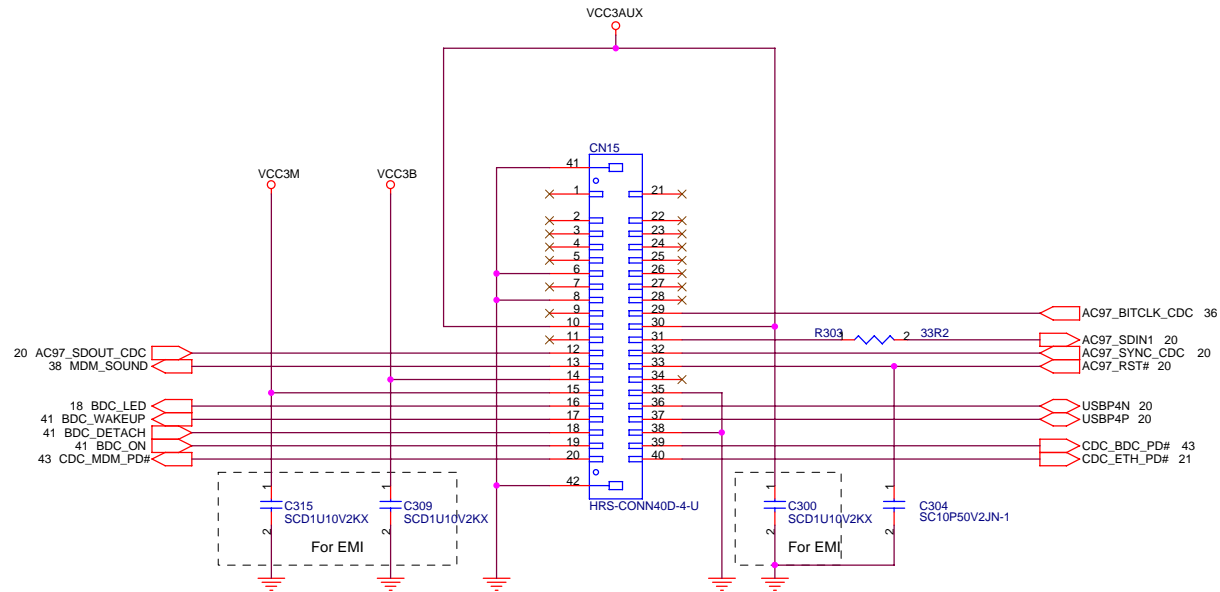
KEEP AWAY FROM OTHER
TRACES

緯創資通 Wistron Corporation
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Title		
RJ11/RJ45 CONN		
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20,27,31 P_C/BE#[0..3]
20,27,31 P_AD#[0..31]





Part Number is updated to 20.F0430.040
New connector is going to rearrange the pin number.

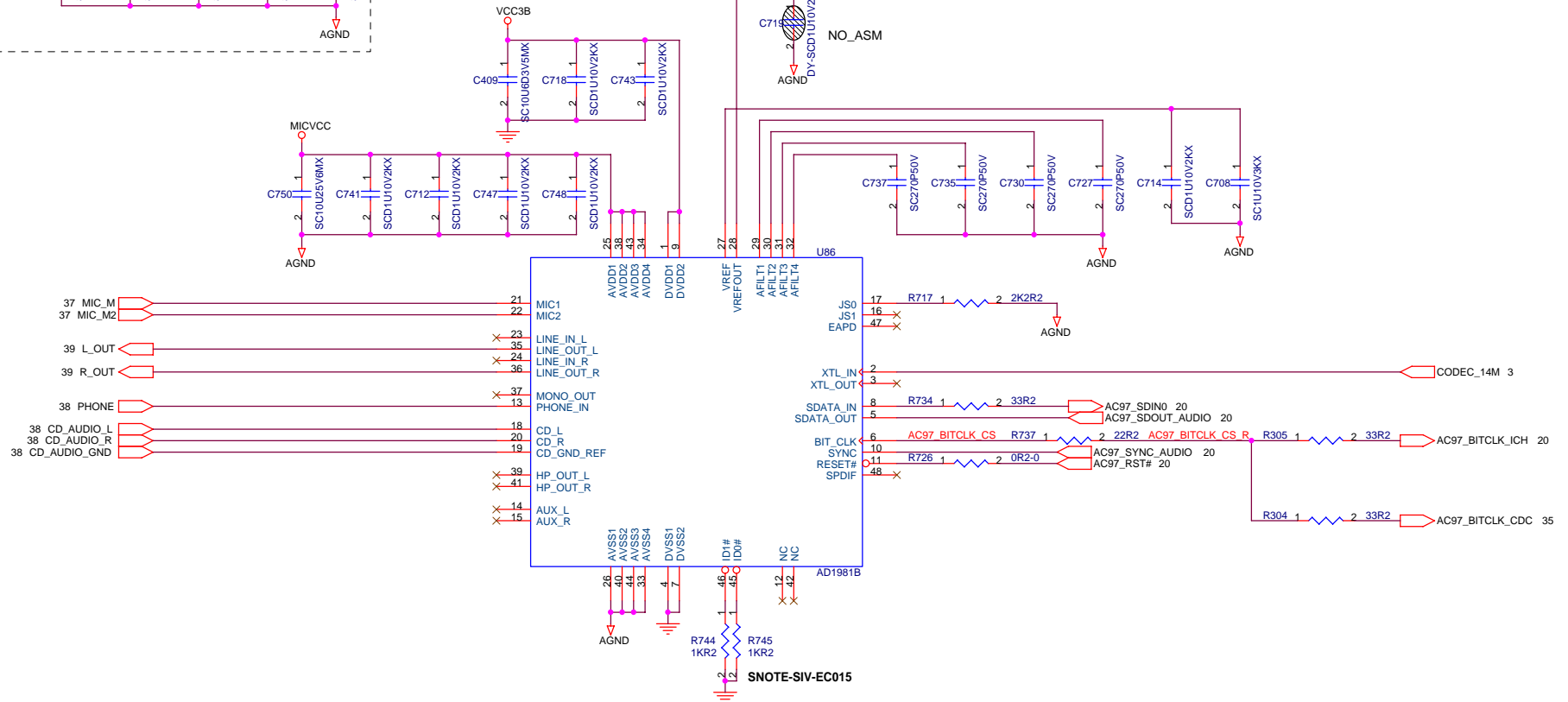
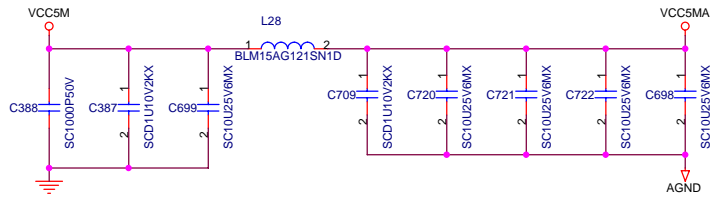
緯創資通

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Title			
CDC CONNECTOR			
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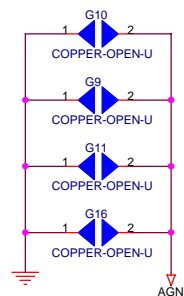
S Note-1

VCC5MA

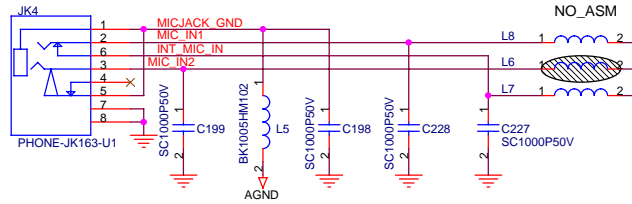


PLACE UNDER AD1981A

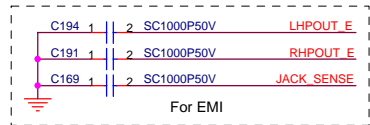
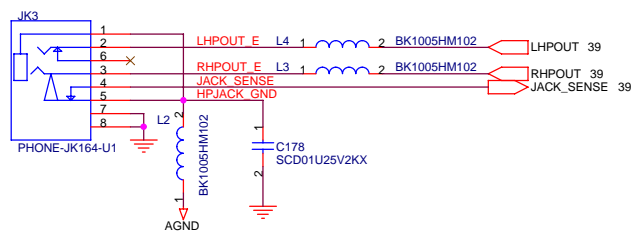
Place near C288



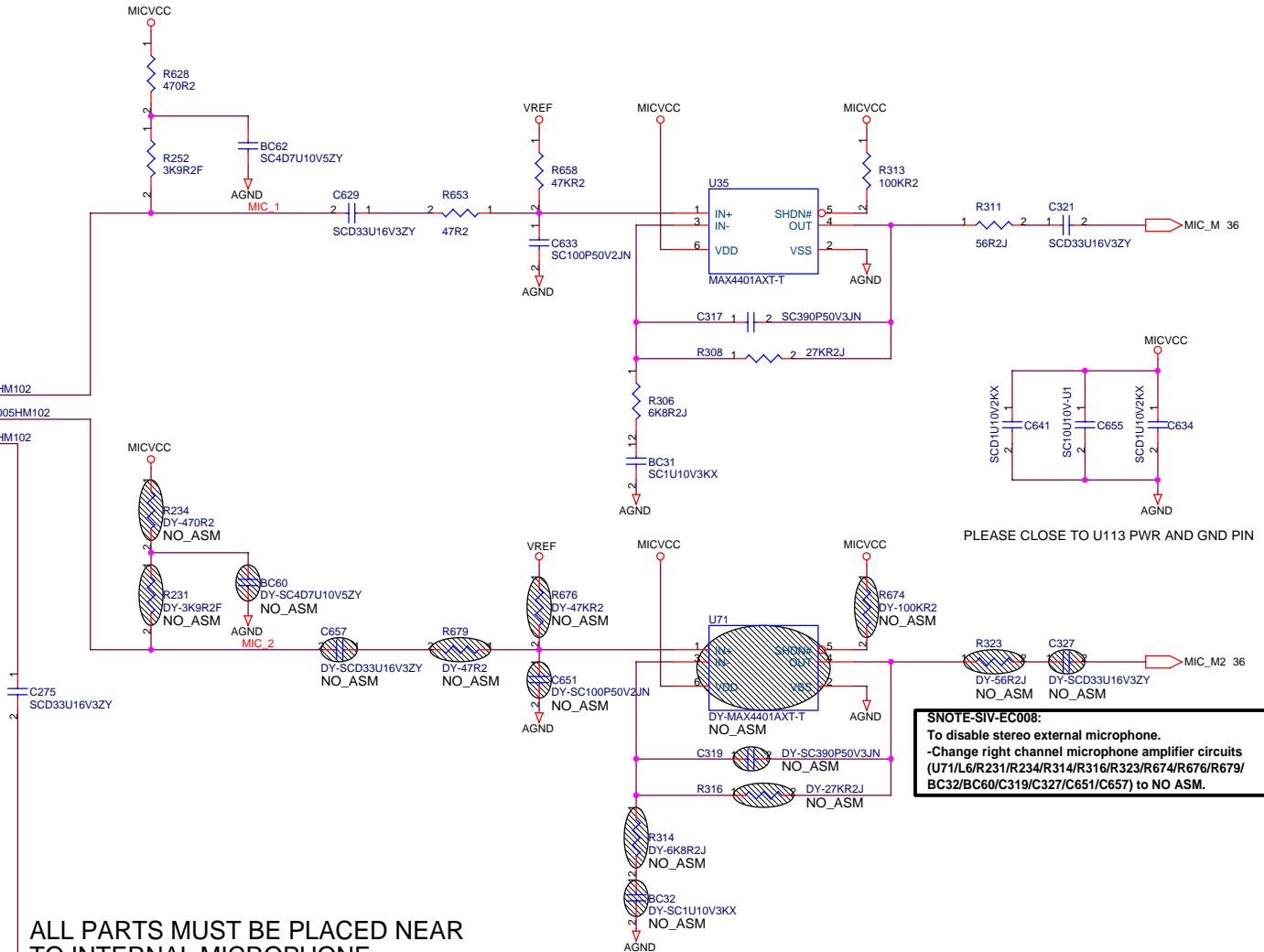
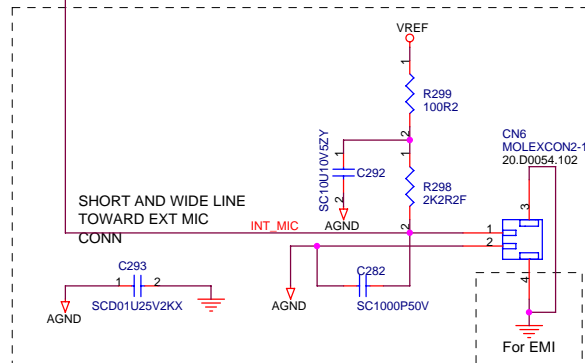
EXT MIC CONN



HEADPHONE CONN



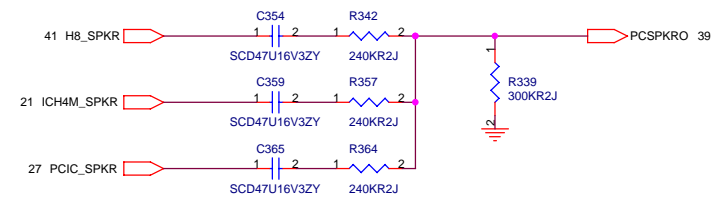
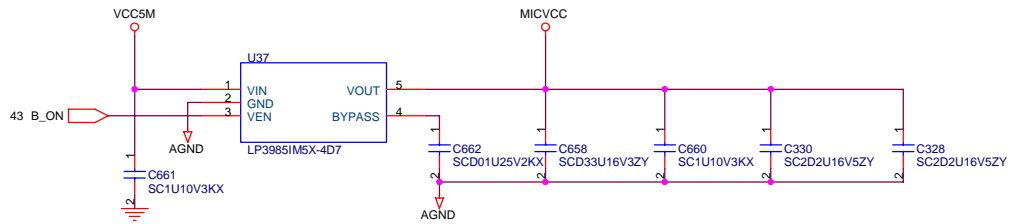
ALL PARTS MUST BE PLACED NEAR TO INTERNAL MICROPHONE



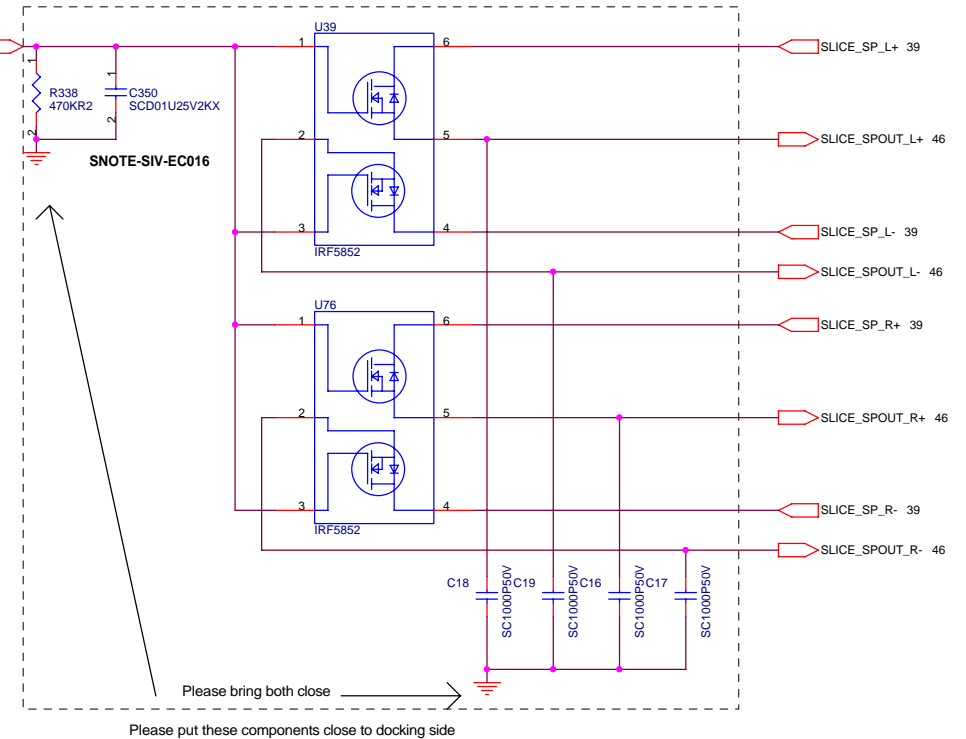
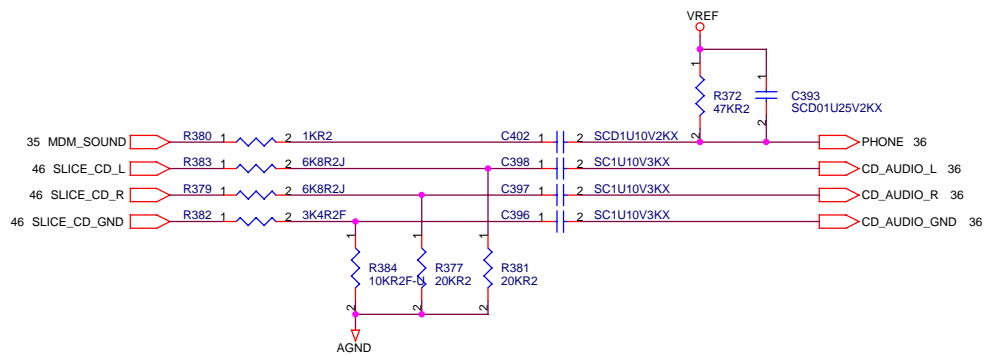
SNOTE-SIV-EC008:
To disable stereo external microphone.
-Change right channel microphone amplifier circuits (U71/L6/R231/R234/R314/R316/R323/R674/R676/R679/BC32/BC60/C319/C327/C651/C657) to NO_ASM.

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Title			
AUDIO MIC & CONN			
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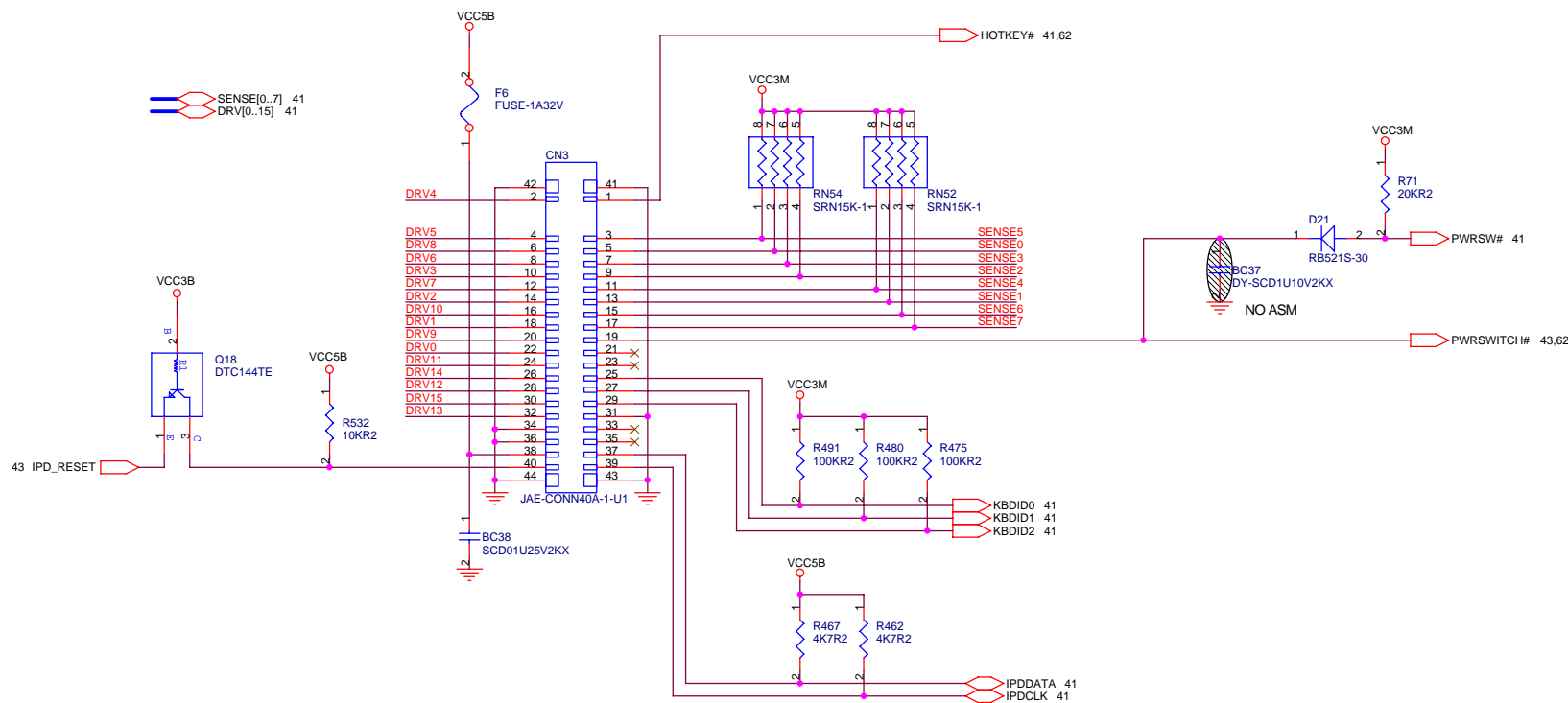
SNOTE-SIV-EC016



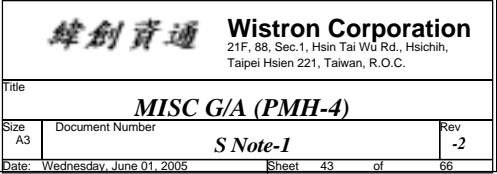
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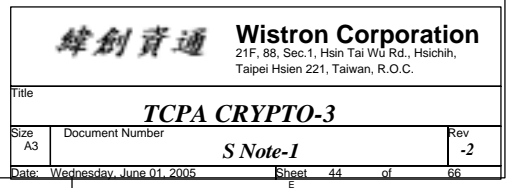
Title			
AUDIO MISC			
Size A3	Document Number		Rev -2
S Note-1			
Date: Wednesday, June 01, 2005		Sheet 38 of	66

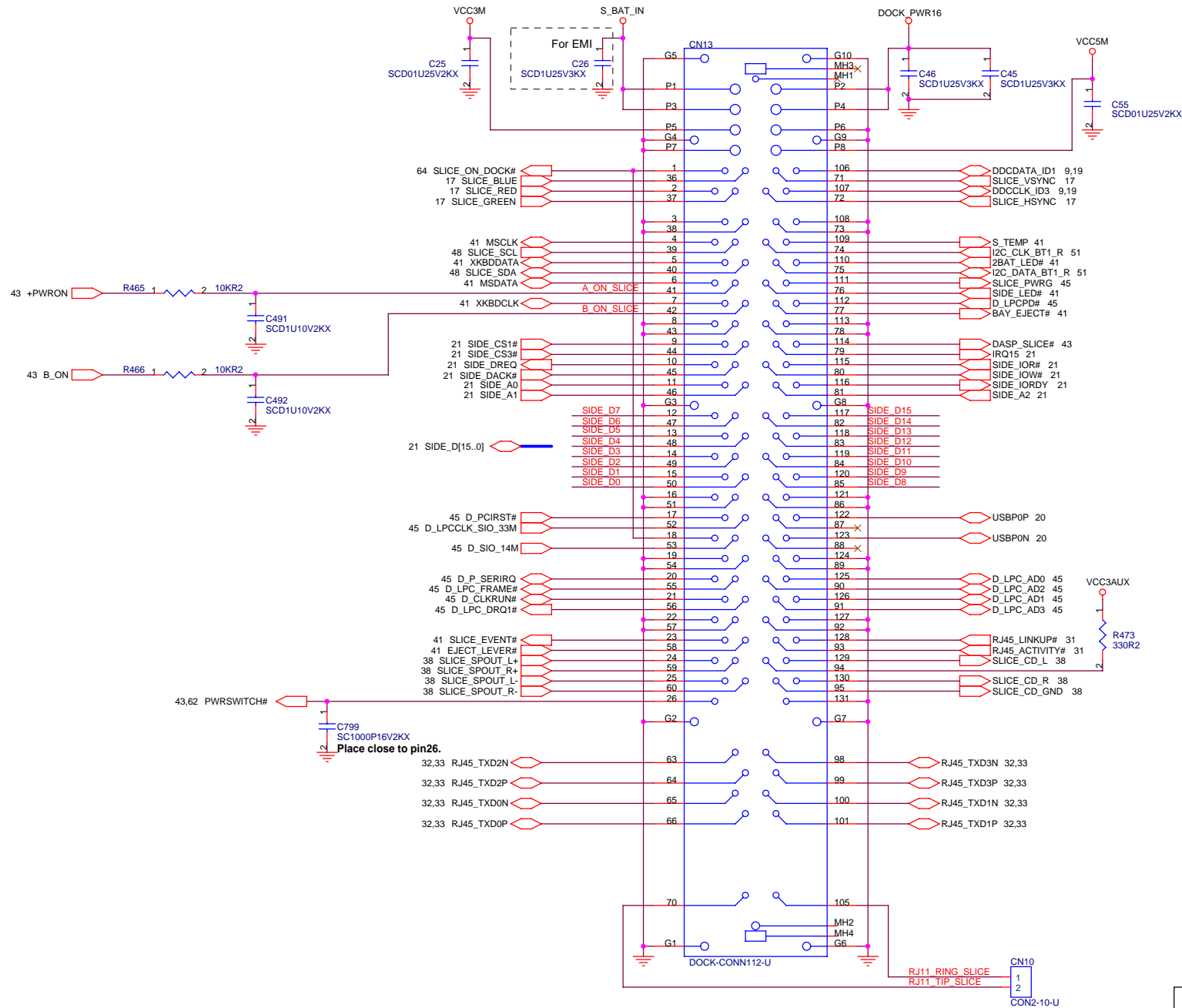
Keyboard Connector



Keyboard Connector Top View







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Title

SLICE CONNECTOR

Size

A3 Document Number

S Note-1

Rev

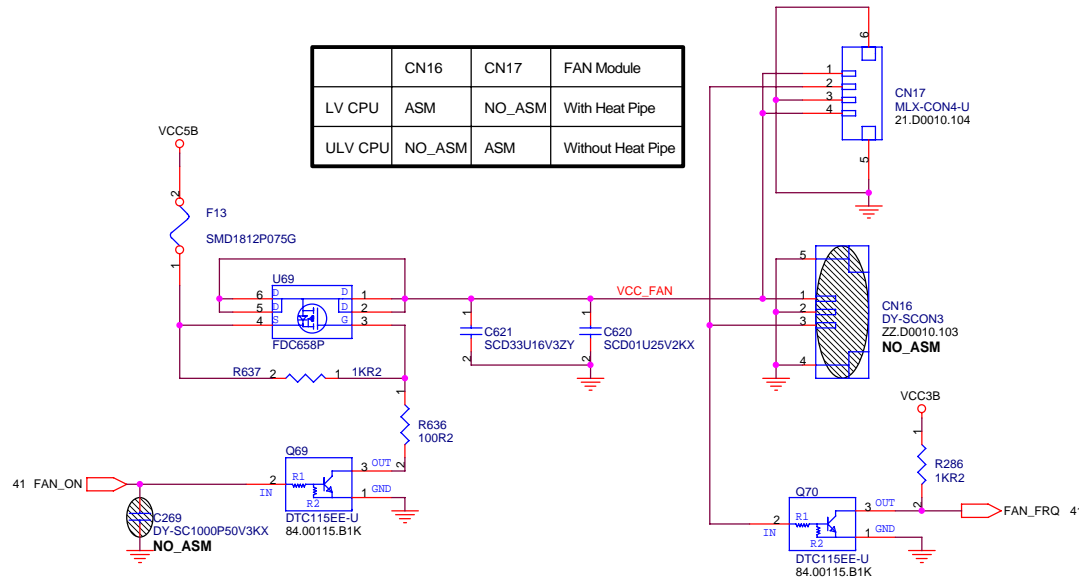
-2

Date: Wednesday, June 01, 2005

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Fan Power Control

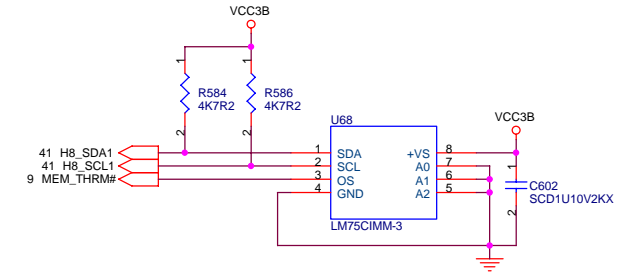
	CN16	CN17	FAN Module
LV CPU	ASM	NO_ASM	With Heat Pipe
ULV CPU	NO_ASM	ASM	Without Heat Pipe



Thermal Sensor LM75 for DDR module

(For DDR throttling implementation)

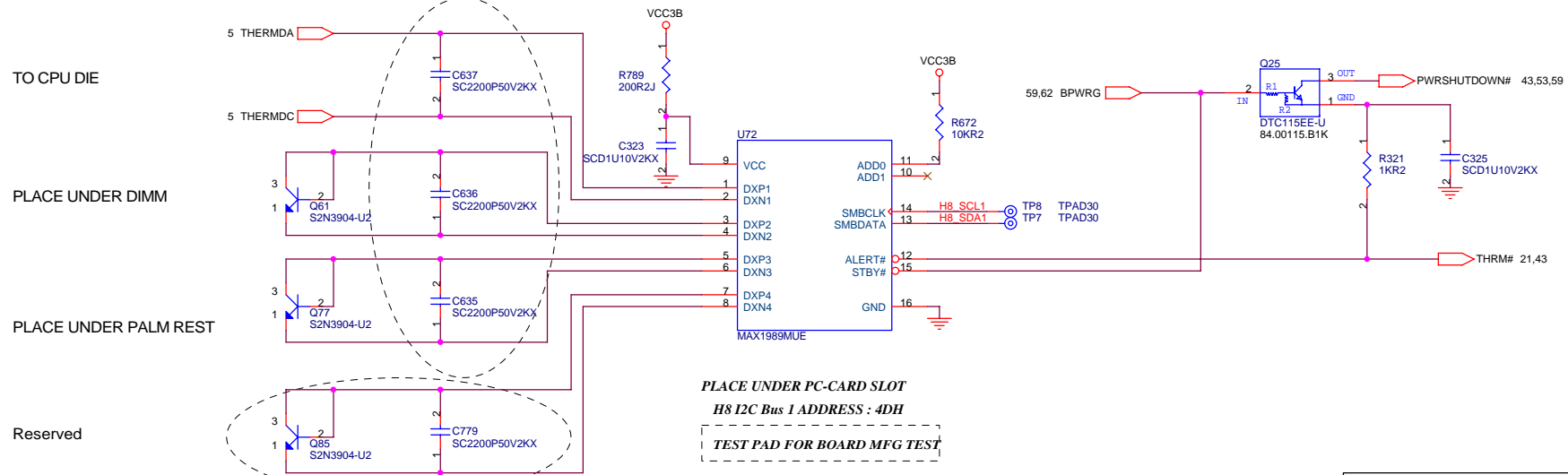
PLACE AT DDR SYSTEM MEMORY AREA



H8 I2C Bus 1 ADDRESS : 48H

Main Source : 74.00075.0B9 (NS)
2nd Source : 74.00075.CB1(MAXIM)
74.07416.0B9 (ADI)

THESE CAPS MUST BE PLACED AS
CLOSE AS POSSIBLE TO MAX1989



PLACE UNDER PC-CARD SLOT

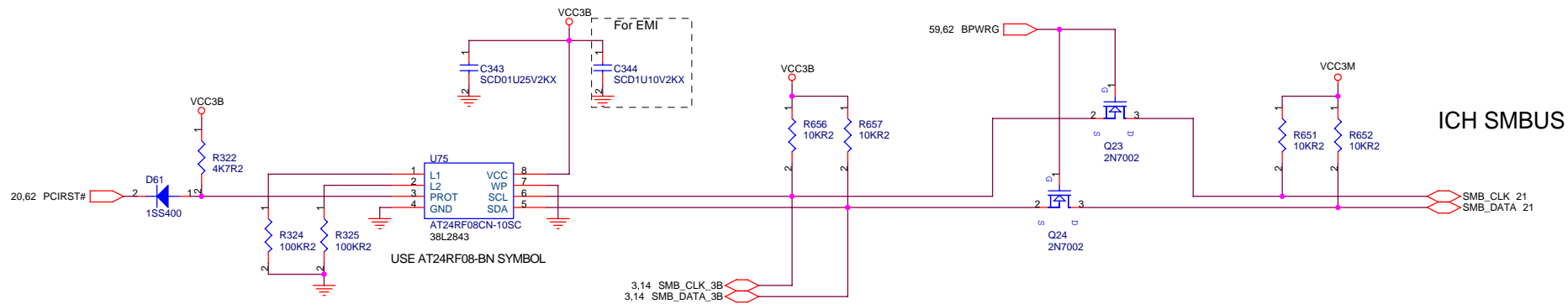
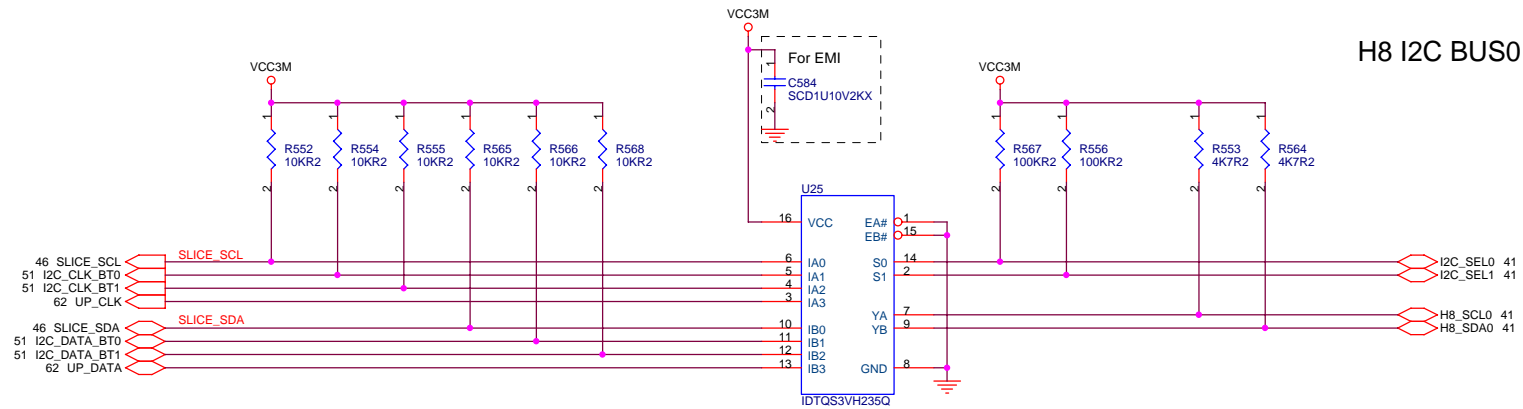
H8 I2C Bus 1 ADDRESS : 4DH

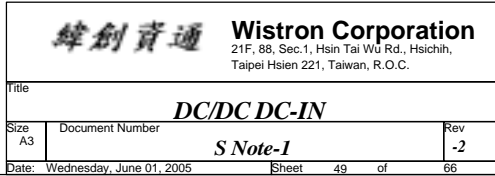
TEST PAD FOR BOARD MFG TEST

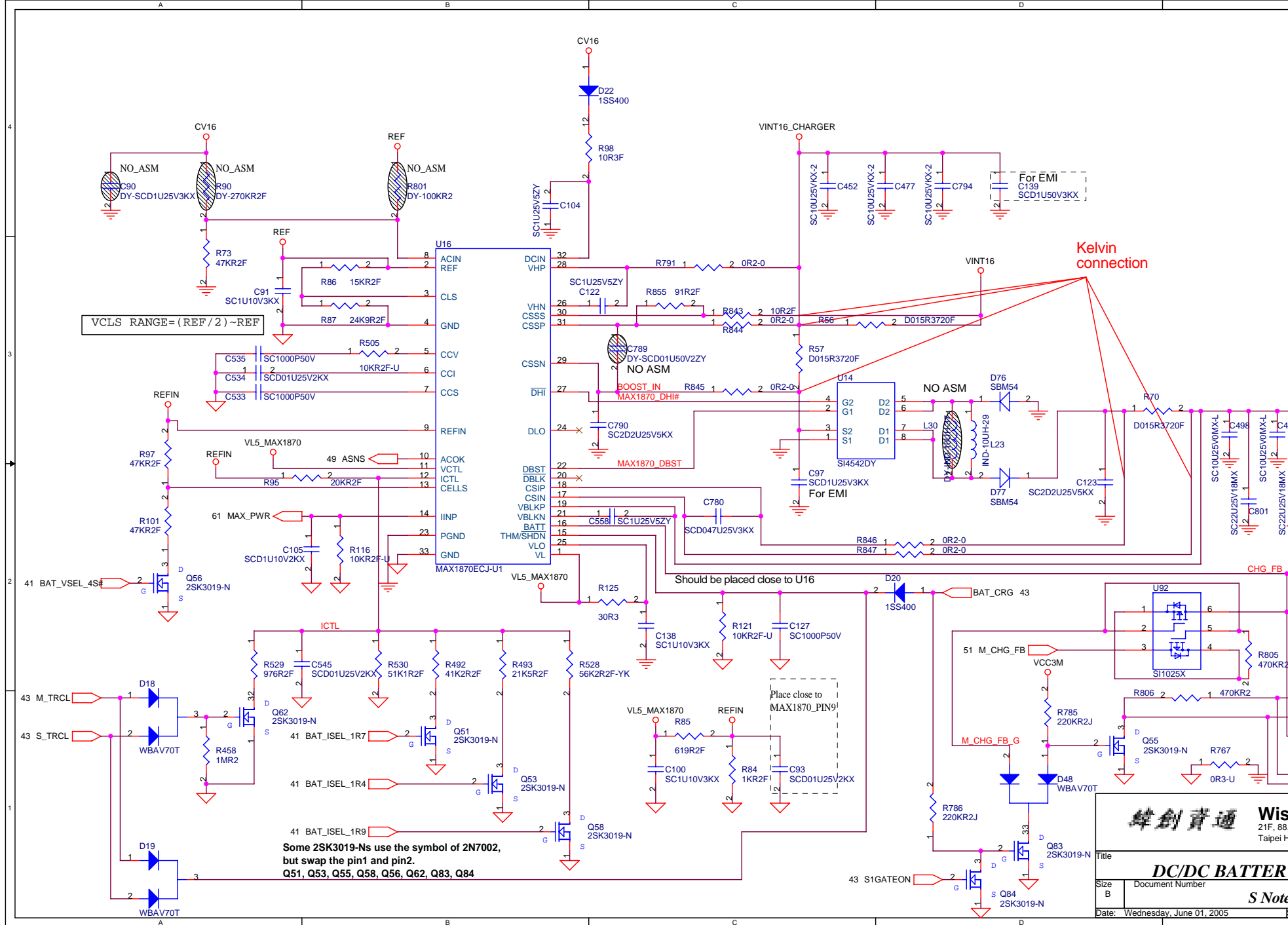
SNOTE-SIV-EC022:
Move near Analog parts.

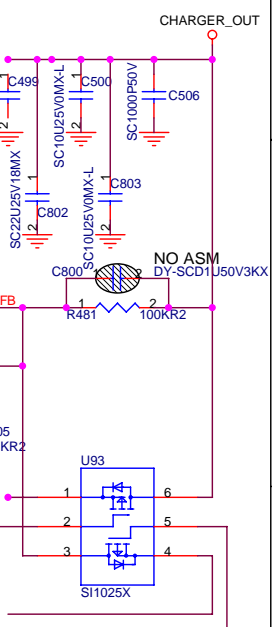
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Title		
FAN & THERMAL SENSOR		
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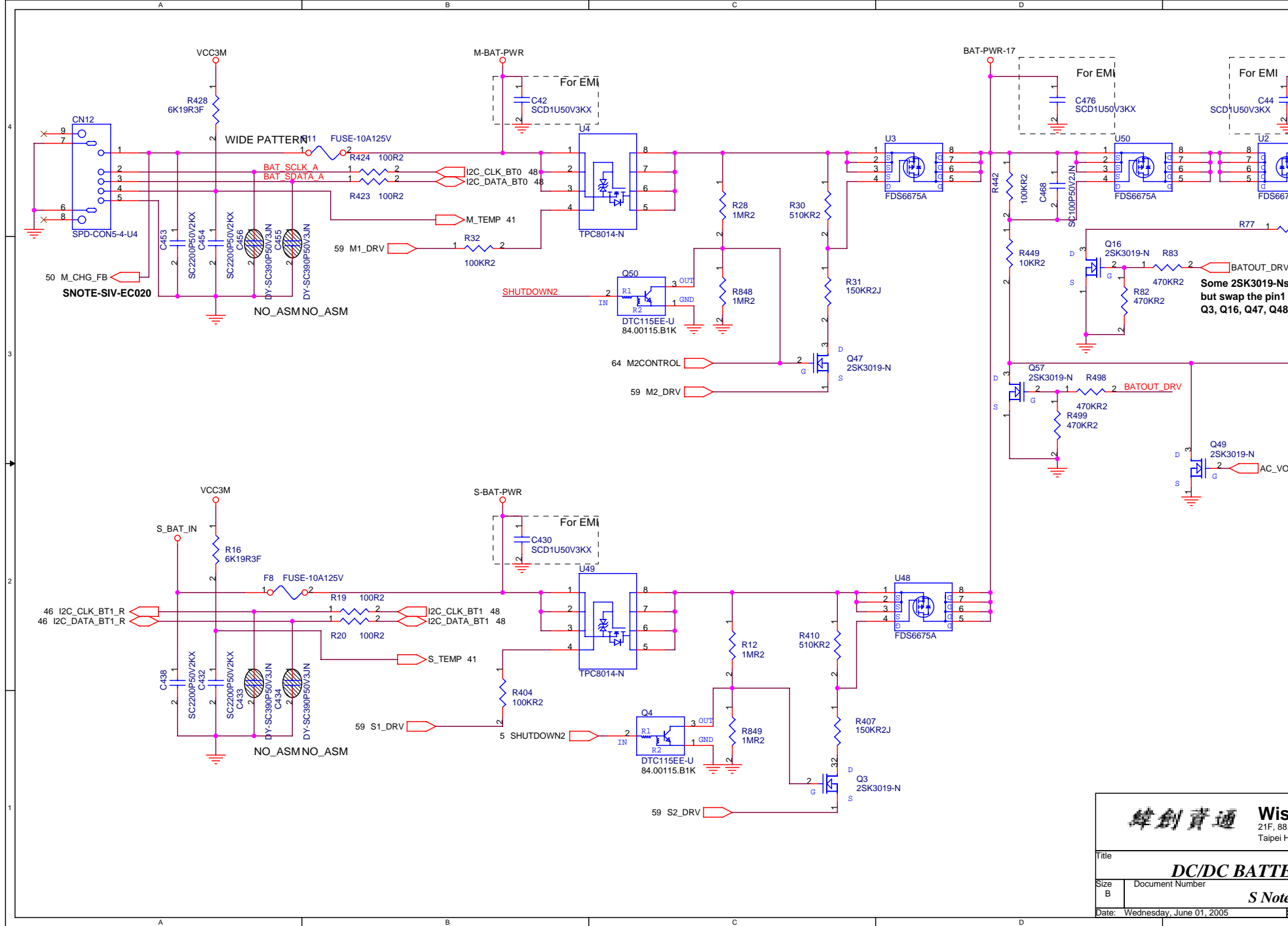


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ERY CHARGER

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緯創資通

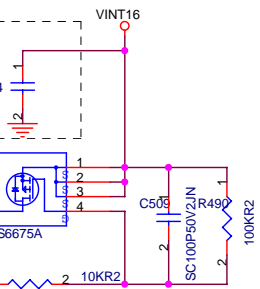
Wis
21F, 88
Taipei H

Title
Size B
Date: Wednesday, June 01, 2005

DC/DC BATTE

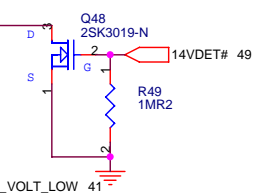
Document Number

S Note



DRV 59

Q48, Q49, Q57
 -Ns use the symbol of 2N7002,
 in1 and pin2.



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pei Hsien 221, Taiwan, R.O.C.

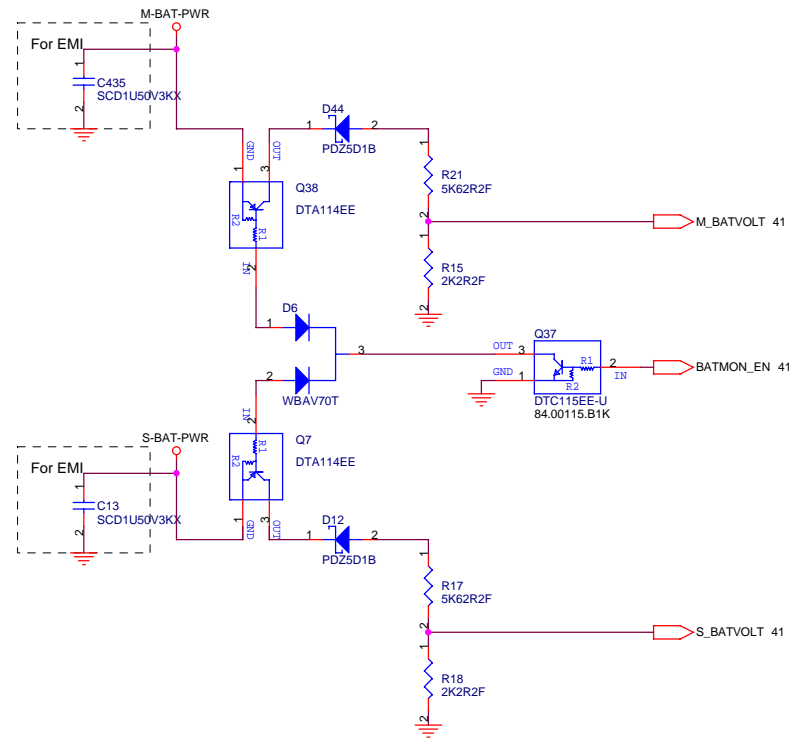
PRIMARY INPUT

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E

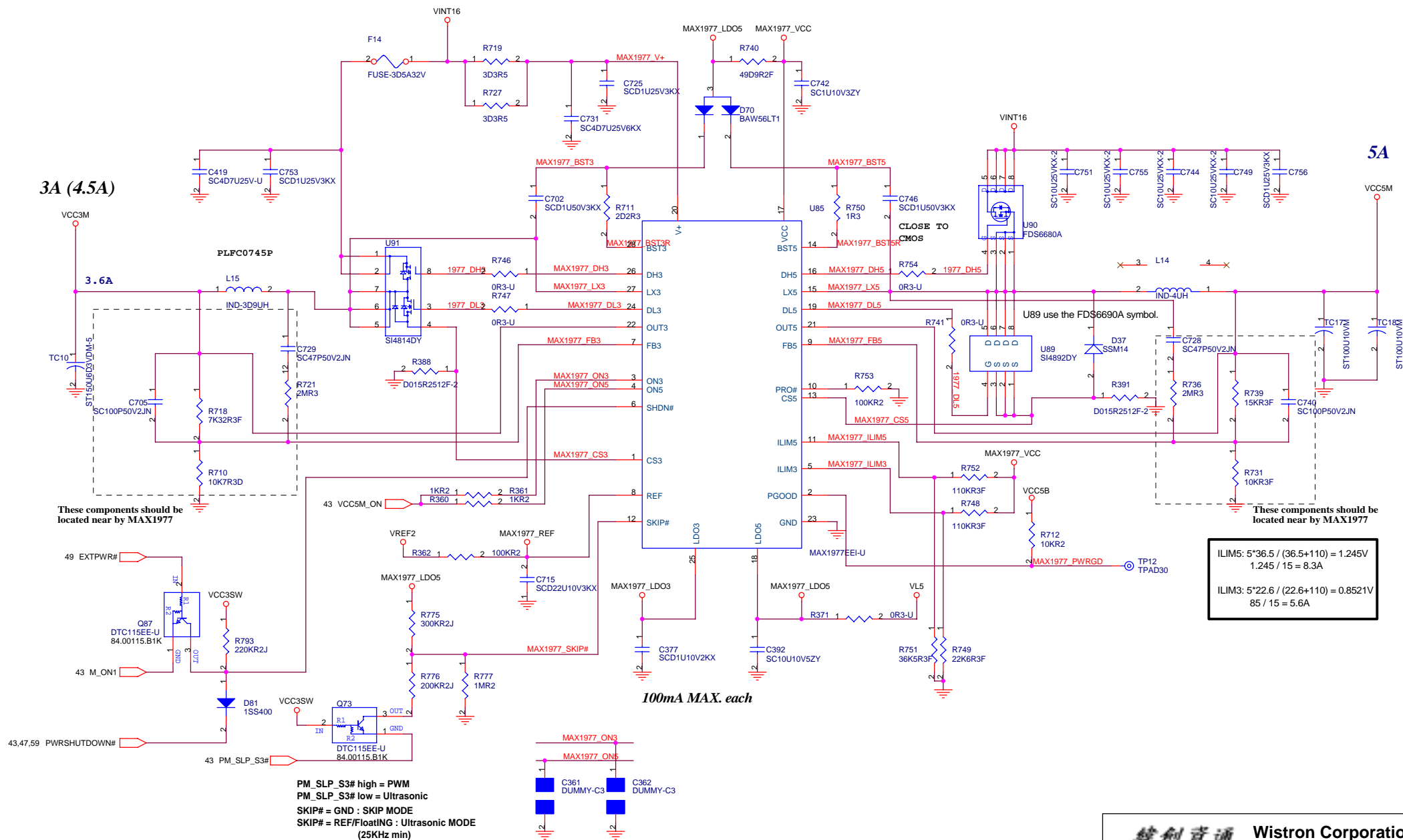


緯創資通

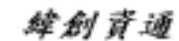
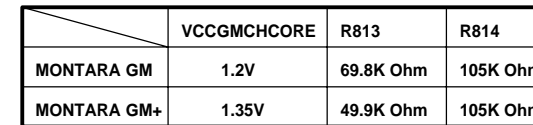
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Title			
DC/DC BATTERY MONITOR			
Size	Document Number	Rev	
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SYSTEM DC/DC 3D3V_S5/5V S5/2D5V_S5



MAX1992 CPU I/O



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Title			
<i>DC/DC VCCGMCHCORE & VCCCPUIO</i>			
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Ton : Vref =>450KHz
OVP/UVP : Vcc =>Enable OVP and
discharge mode, enable UVP

$$7.8 * 1.5 = 11.7$$

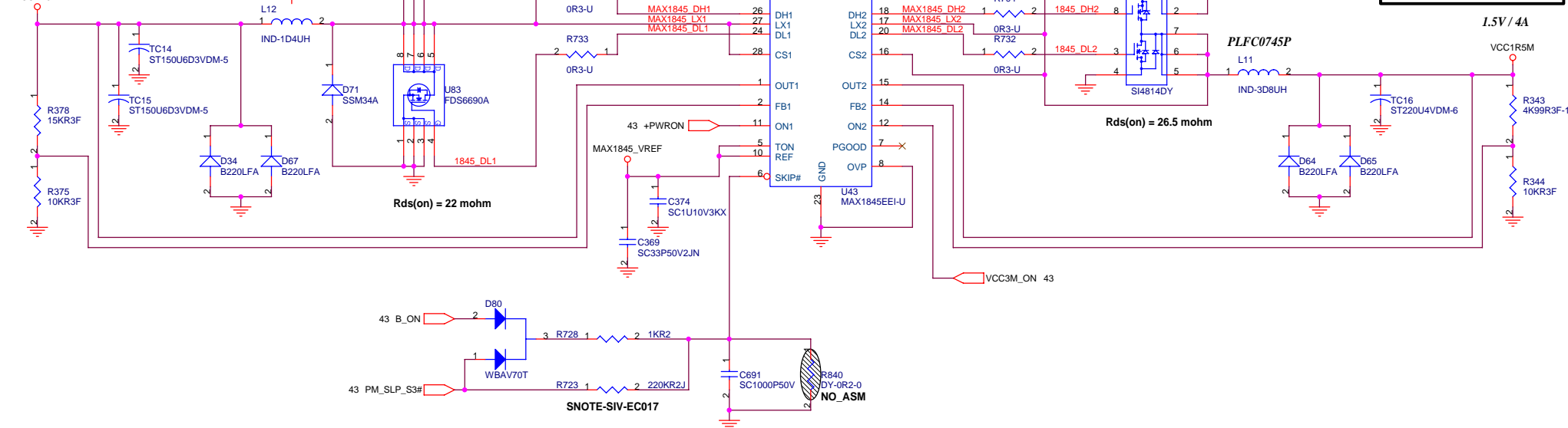
$$(11.7 + 1.1) * 17 = 218\text{mV}$$

$$\text{ILIM1: } 5 * 60.4 / (100 + 60.4) = 1.88\text{V}$$

$$\text{OCP1: } 188 / 13 = 14.6\text{A}$$

2.5V / 7.8A

VCC2R5A



$$4(\text{A}) * 1.5 = 6(\text{A})$$

$$6 * 26.5 = 159\text{mV}$$

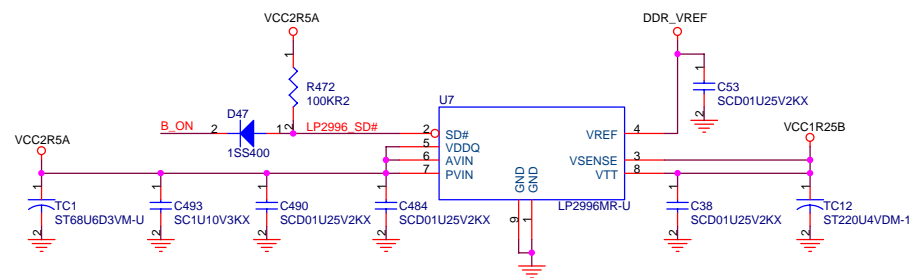
$$\text{ILIM2: } 5 * 47.5 / (100 + 47.5) = 1.61\text{V}$$

$$\text{OCP2: } 161 / 26.5 = 6.07\text{A}$$

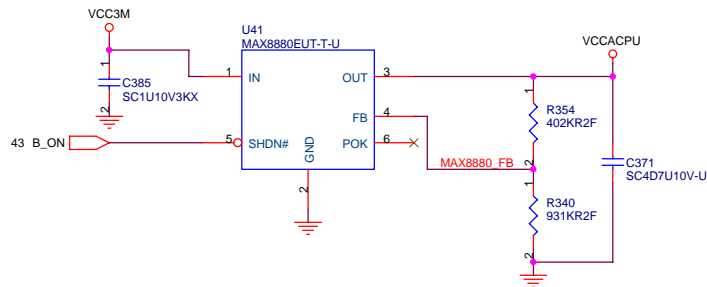
緯創資通 Wistron Corporation
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Title			
DC/DC VCC2R5A & VCC1R5M			
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VCC1R25B & DDR_VREF

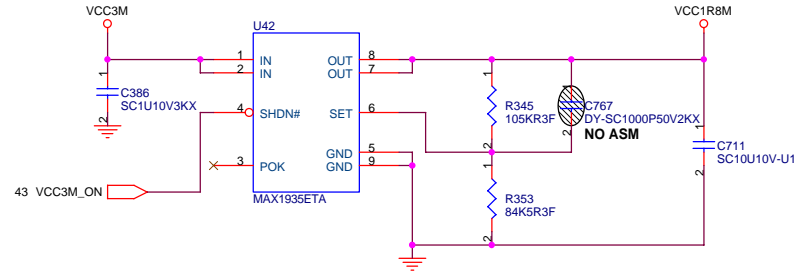


VCCACPU

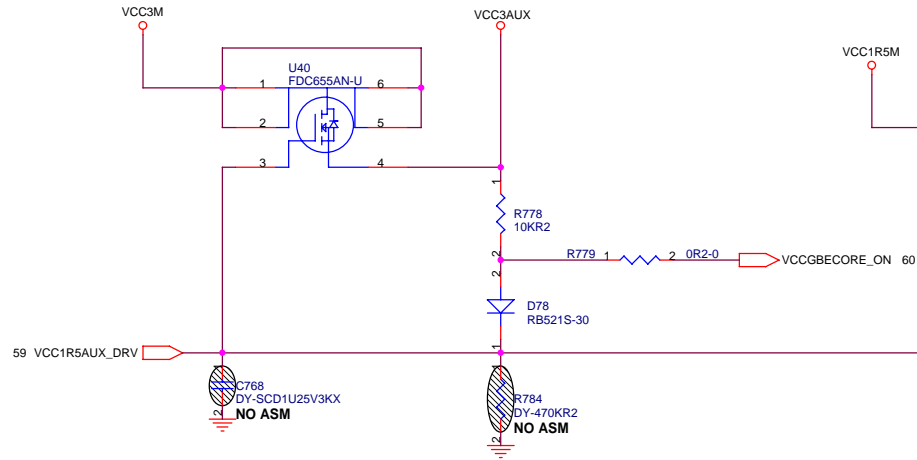


	R354	VCCACPU
BANIAS	402Kohm	1.80V
DOTHAN	187Kohm	1.50V

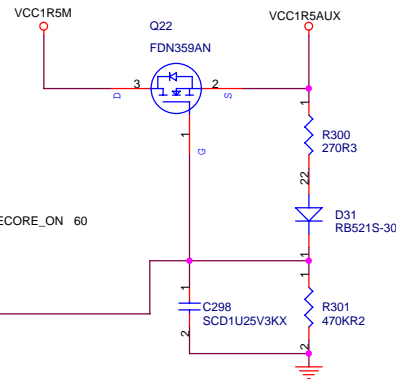
VCC1R8M



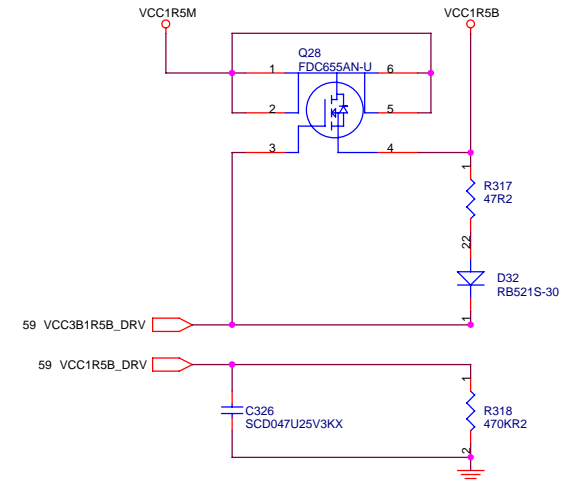
VCC3AUX



VCC1R5AUX

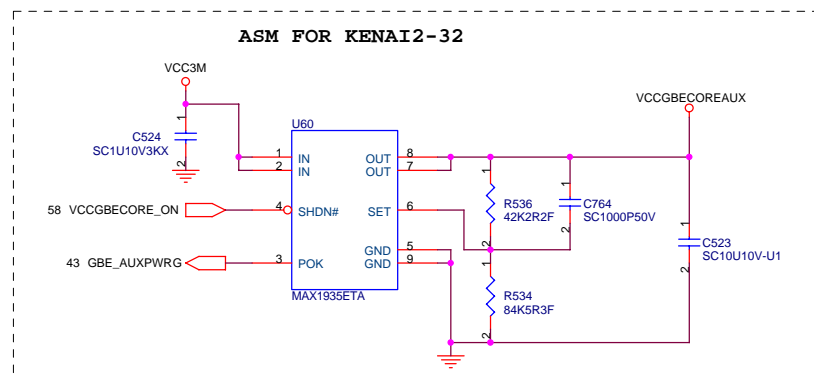
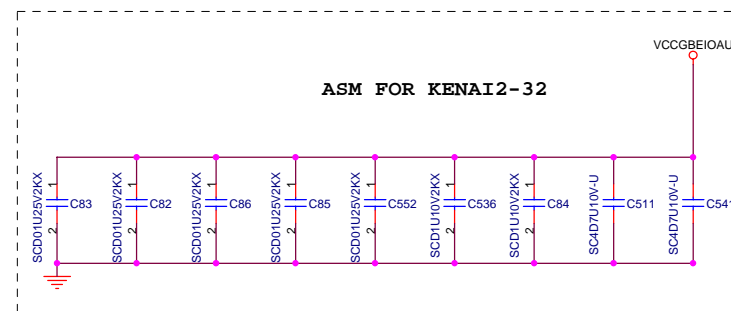
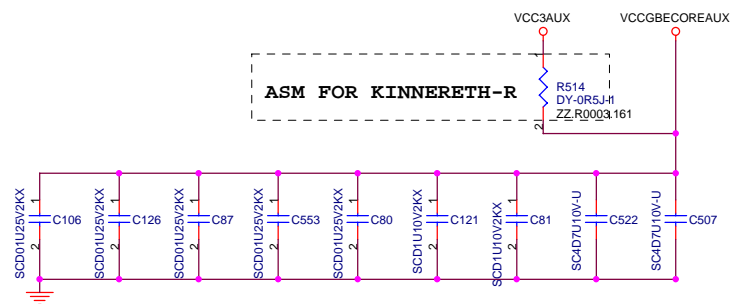


VCC1R5B

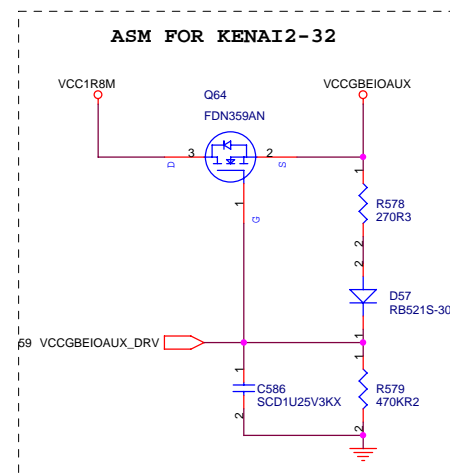


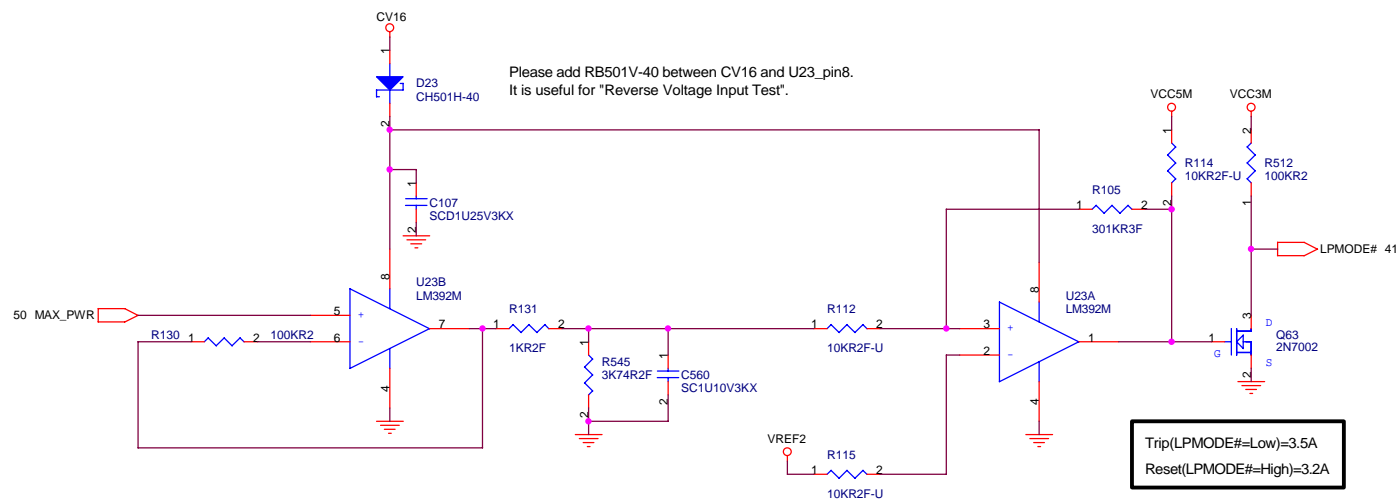
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Title			
<i>DC/DC VCC1R8M & LOAD SW</i>			
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	KENAI2-32	KINNERETH-R
VCCGBECOREAUX	1.2V	3.3V
VCCGBEIOAUX	1.8V	N.C





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Title

MAX POWER CONTROL

Size
A3

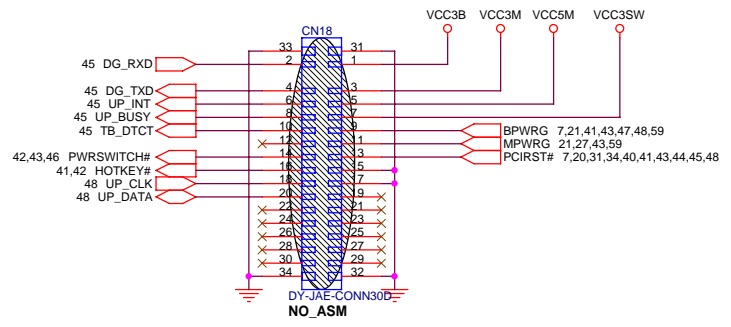
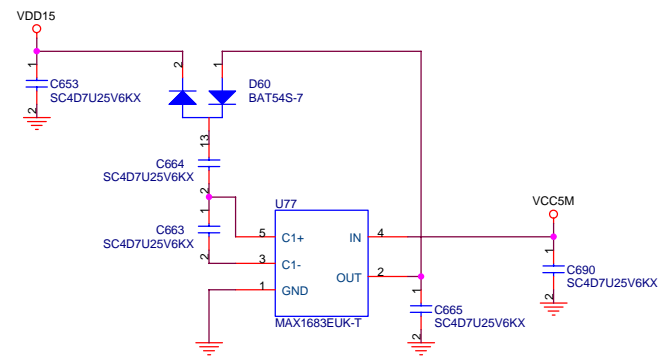
Document Number

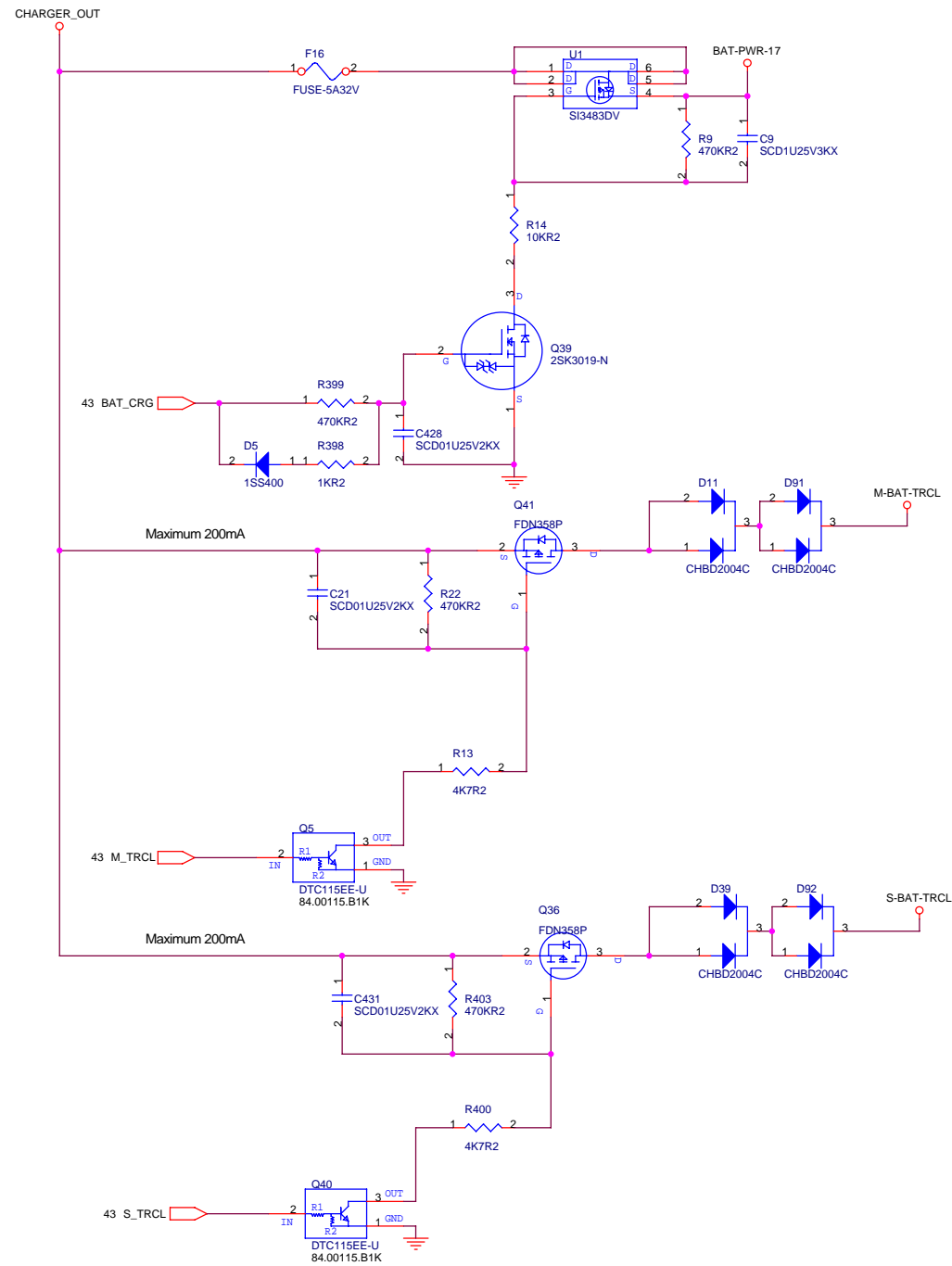
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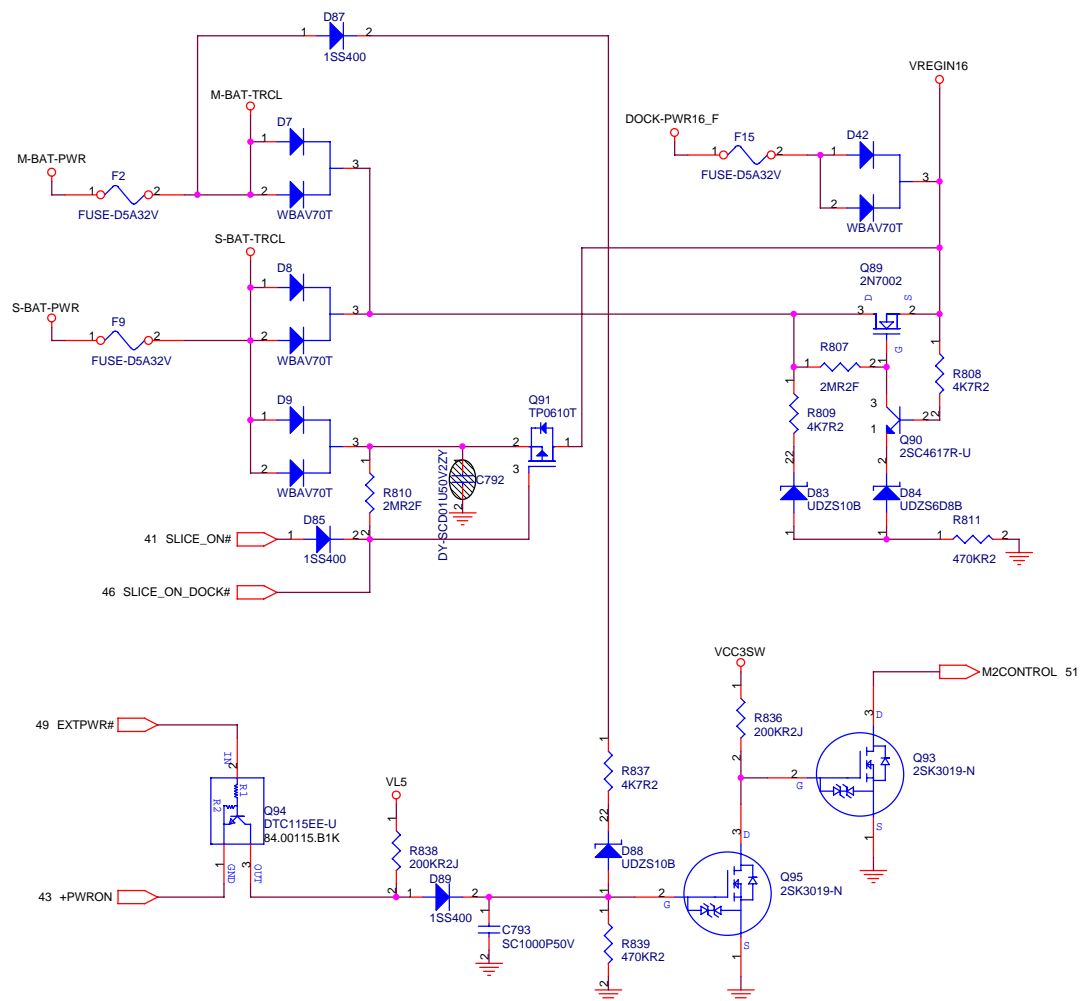




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Title			
DC/DC CHARGER SELECT			
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Title

VREGIN16

Size
A3

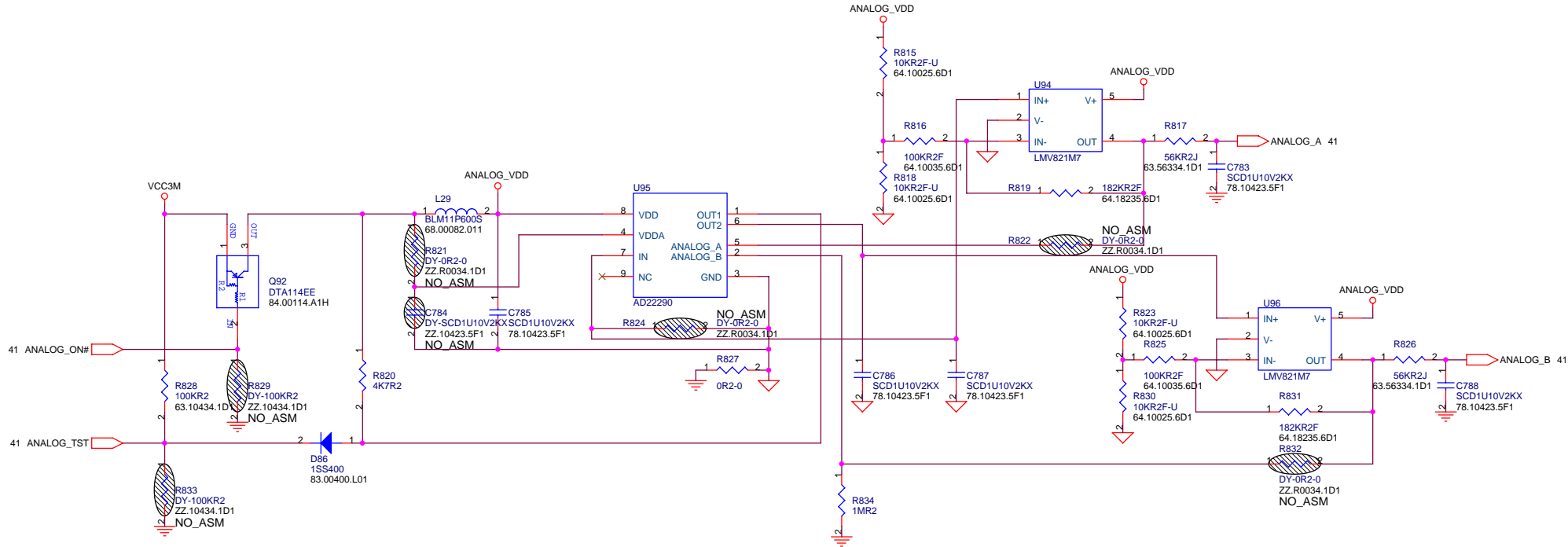
Document Number

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Accelerometer Parts List

Page	Usage Code	AD22290	MEMSIC	NO ACC.
41	R138 (100K 5%)	NO_ASM	NO_ASM	ASM
41	R141 (100K 5%)	NO_ASM	NO_ASM	ASM
41	R148 (100K 5%)	NO_ASM	NO_ASM	NO_ASM
41	R149 (100K 5%)	NO_ASM	NO_ASM	NO_ASM
65	R829 (100K 5%)	NO_ASM	NO_ASM	ASM
65	R833 (100K 5%)	NO_ASM	ASM	ASM
65	U94 (LMV821M7)	ASM	NO_ASM	NO_ASM
65	U95 (AD22290)	ASM	MXA2500GL	NO_ASM
65	U96 (LMV821M7)	ASM	NO_ASM	NO_ASM
65	Q92 (DTA114EE)	ASM	ASM	NO_ASM
65	D86 (1SS400)	ASM	NO_ASM	NO_ASM
65	L29 (BLM11P600S)	ASM	ASM	NO_ASM
65	R815 (10K 1%)	ASM	NO_ASM	NO_ASM
65	R816 (100K 1%)	ASM	NO_ASM	NO_ASM
65	R817 (56K 5%)	ASM	8.2K 5%	NO_ASM
65	R818 (10K 1%)	ASM	NO_ASM	NO_ASM
65	R819 (182K 1%)	ASM	NO_ASM	NO_ASM
65	R820 (4.7K 5%)	ASM	NO_ASM	NO_ASM
65	R823 (10K 1%)	ASM	NO_ASM	NO_ASM
65	R825 (100K 1%)	ASM	NO_ASM	NO_ASM
65	R826 (56K 5%)	ASM	8.2K 5%	NO_ASM
65	R827 (0ohm 5%)	ASM	ASM	NO_ASM

Page	Usage Code	AD22290	MEMSIC	NO ACC.
65	R828 (100K 5%)	ASM	NO_ASM	NO_ASM
65	R830 (10K 1%)	ASM	NO_ASM	NO_ASM
65	R831 (182K 1%)	ASM	NO_ASM	NO_ASM
65	R834 (1M 5%)	ASM	NO_ASM	NO_ASM
65	C783 (0.1u 10%10V)	ASM	ASM	NO_ASM
65	C785 (0.1u 10%10V)	ASM	ASM	NO_ASM
65	C786 (0.1u 10%10V)	ASM	NO_ASM	NO_ASM
65	C787 (0.1u 10%10V)	ASM	NO_ASM	NO_ASM
65	C788 (0.1u 10%10V)	ASM	ASM	NO_ASM
65	R821 (0ohm 5%)	NO_ASM	ASM	NO_ASM
65	R822 (0ohm 5%)	NO_ASM	ASM	NO_ASM
65	R824 (0ohm 5%)	NO_ASM	ASM	NO_ASM
65	R832 (0ohm 5%)	NO_ASM	ASM	NO_ASM
65	C784 (0.1u 10%10V)	NO_ASM	ASM	NO_ASM

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Title

ACCELERO METER

Size A3

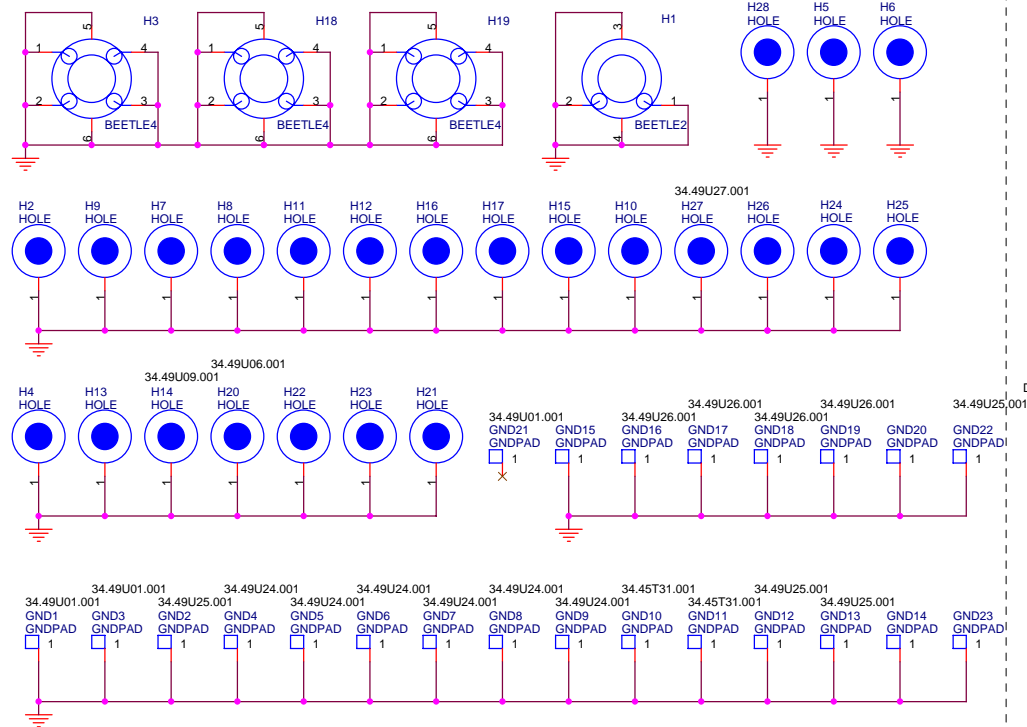
Document Number

S Note-1

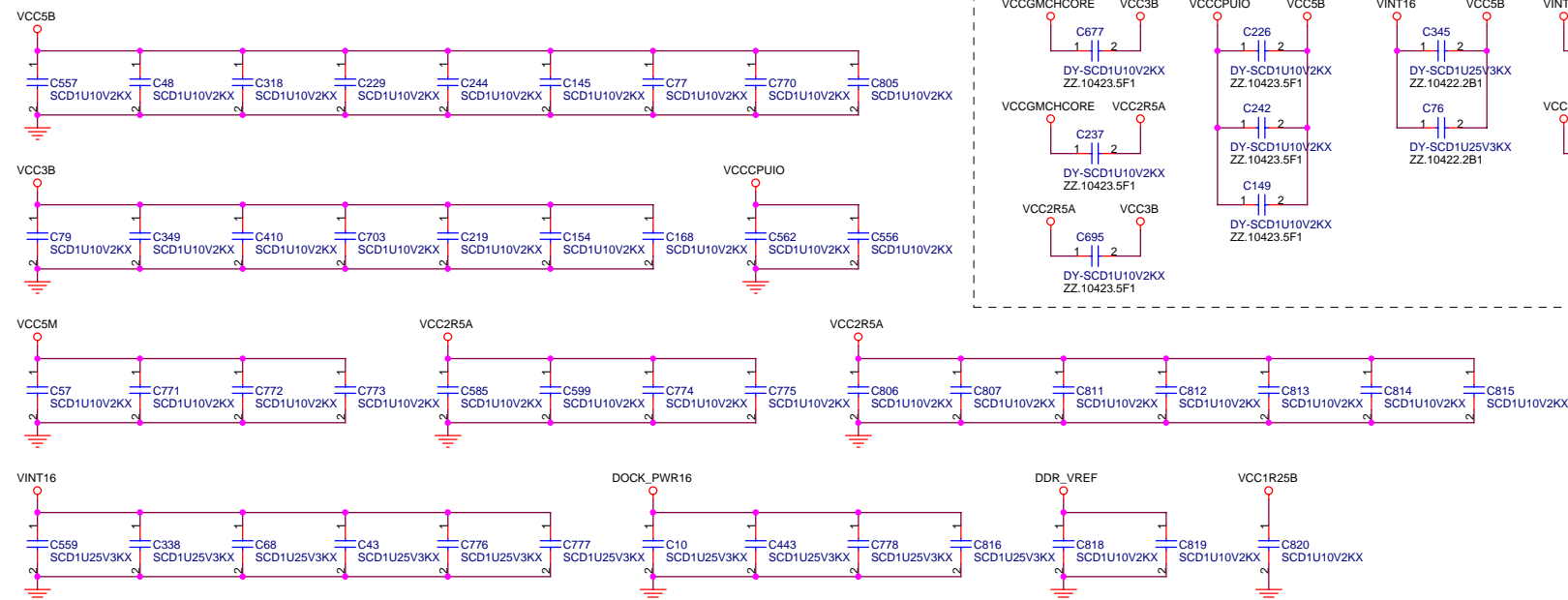
Rev -2

Date: Wednesday, June 01, 2005

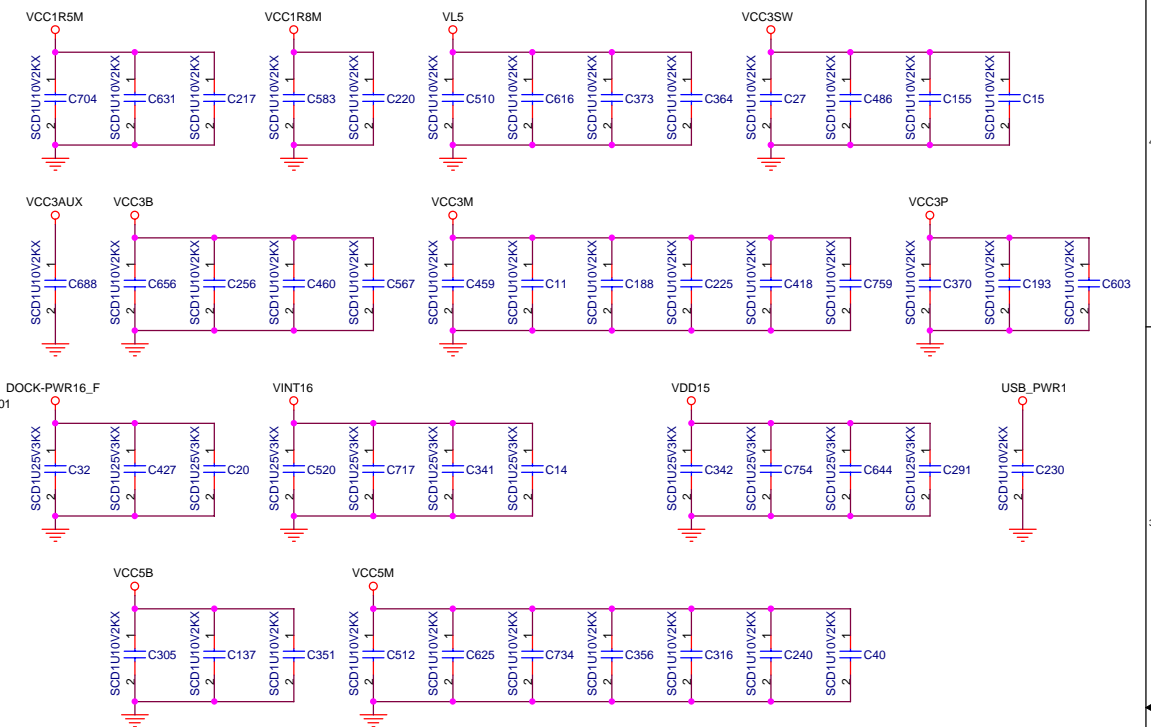
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POWER PLANE



LONG POWER TRACE



CROSS MOAT

